M38510-001 (5401)

Microcircuits, Digital, TTL, NAND Gates, Monolithic Silicon

Rochester Electronics Manufactured Components

Rochester branded components are manufactured using either die/wafers purchased from the original suppliers or Rochester wafers recreated from the original IP. All re-creations are done with the approval of the Original Component Manufacturer (OCM).

Parts are tested using original factory test programs or Rochester developed test solutions to guarantee product meets or exceeds the OCM data sheet.

Quality Overview

• ISO-9001
• AS9120 certification
• Qualified Manufacturers List (QML) MIL-PRF-35835
    • Class Q Military
    • Class V Space Level
• Qualified Suppliers List of Distributors (QSLD)
    • Rochester is a critical supplier to DLA and meets all industry and DLA standards.

Rochester Electronics, LLC is committed to supplying products that satisfy customer expectations for quality and are equal to those originally supplied by industry manufacturers.

The original manufacturer's datasheet accompanying this document reflects the performance and specifications of the Rochester manufactured version of this device. Rochester Electronics guarantees the performance of its semiconductor products to the original OCM specifications. 'Typical' values are for reference purposes only. Certain minimum or maximum ratings may be based on product characterization, design, simulation, or sample testing.

FOR REFERENCE ONLY

INCH-POUND

MIL-M-38510/1F
16 March 2005
SUPERSEDING
MIL-M-38510/1E
1 June 1982

MILITARY SPECIFICATION

MICROCIRCUITS, DIGITAL, TTL, NAND GATES,
MONOLITHIC SILICON

This specification is approved for use by all Departments
and Agencies of the Department of Defense.

The requirements for acquiring the product herein shall consist of this specification sheet and MIL-PRF 38535

1. SCOPE

1.1 Scope. This specification covers the detail requirements for monolithic silicon, TTL, positive NAND logic gating microcircuits. Two product assurance classes and a choice of case outlines and lead finishes are provided for each type and are reflected in the complete part number. For this product, the requirements of MIL-M-38510 have been superseded by MIL-PRF-38535, (see 6.3).

1.2 Part or Identifying Number (PIN). The PIN is in accordance with MIL-PRF-38535, and as specified herein.

1.2.1 Device types. The device types are as follows:

Device type	Circuit
01	Single, 8-input positive NAND gate
02	Dual, 4-input positive NAND gate
03	Triple, 3-input positive NAND gate
04	Quadruple, 2-input positive NAND gate
05	Hex, 1-input inverter gate
06	Triple, 3-input positive NAND gate (open collector output)
07	Quadruple, 2-input positive NAND gate (open collector output)
08	Hex, 1-input inverter gate (open collector output)
09	Same as device type 07, except different pin connections

1.2.2 Device class. The device class is the product assurance level as defined in MIL-PRF-38535.

1.2.3 Case outlines. The case outlines are as designated in MIL-STD-1835 and as follows:

Outline letter	Descriptive designator	Terminals	Package style
A	GDFP5-F14 or CDFP6-F14	14	Flat
B	GDFP4-F14	14	Flat
C	GDIP1-T14 or CDIP2-T14	14	Dual-in-line
D	GDFP1-F14 or CDFP2-F14	14	Flat

Comments, suggestions, or questions on this document should be addressed to: Commander, Defense Supply Center Columbus, ATTN: DSCC-VAS, P.O. Box 3990, Columbus, OH 43218-3990, or emailed to bipolar@dla.mil . Since contact information can change, you may want to verify the currency of this address information using the ASSIST Online database at http://assist.daps.dla.mil .

1.3 <u>Absolute maximum ratings.</u>

Supply voltage range ....-0.5 V to +7.0 V
Input voltage range ....-1.5 V at -12 mA to +5.5 V
Storage temperature range .... -65° to +150°C
Maximum power dissipation per gate (P_D) <u>1</u>/......................... 40 mW
Lead temperature (soldering, 10 seconds) .... 300°C
Thermal resistance, junction to case (θ_{JC}) .... (See MIL-STD-1835)
Junction temperature (T_J) <u>2</u>/.. 175°C

1.4 <u>Recommended operating conditions.</u>

Supply voltage.. +4.5 V minimum to +5.5 V maximum
Minimum high level input voltage .... +2.0 V
Maximum low level input voltage (V_{IL}) .... +0.8 V
Normalized fanout (each output) <u>3</u>/...................................... 10 maximum
Case operating temperature range .... -55° to +125°C

<u>   </u>
<u>1</u>/ Must withstand the added P_D due to short-circuit test (e.g., I_{OS}).
<u>2</u>/ Maximum junction temperature shall not be exceeded except for allowable short duration burn-in
screening conditions in accordance with MIL-PRF-38535.
<u>3</u>/ Device will fanout in both high and low levels to the specified number of inputs of the same device type
as that being tested.

2. APPLICABLE DOCUMENTS

2.1 General. The documents listed in this section are specified in sections 3, 4, or 5 of this specification. This section does not include documents cited in other sections of this specification or recommended for additional information or as examples. While every effort has been made to ensure the completeness of this list, document users are cautioned that they must meet all specified requirements of documents cited in sections 3, 4, or 5 of this specification, whether or not they are listed.

2.2 Government documents.

2.2.1 Specifications and Standards. The following specifications and standards form a part of this specification to the extent specified herein. Unless otherwise specified, the issues of these documents are those cited in the solicitation or contract.

DEPARTMENT OF DEFENSE SPECIFICATIONS

MIL-PRF-38535   -   Integrated Circuits (Microcircuits) Manufacturing, General Specification for.

DEPARTMENT OF DEFENSE STANDARDS

MIL-STD-883   -   Test Method Standard for Microelectronics.
MIL-STD-1835   -   Interface Standard Electronic Component Case Outlines

(Copies of these documents are available online at http://assist.daps.dla.mil/quicksearch/ or http://assist.daps.dla.mil or from the Standardization Document Order Desk, 700 Robbins Avenue, Building 4D, Philadelphia, PA 19111-5094.)

2.3 Order of precedence. In the event of a conflict between the text of this specification and the references cited herein, the text of this document takes precedence. Nothing in this document, however, supersedes applicable laws and regulations unless a specific exemption has been obtained.

3. REQUIREMENTS

3.1 Qualification. Microcircuits furnished under this specification shall be products that are manufactured by a manufacturer authorized by the qualifying activity for listing on the applicable qualified manufacturers list before contract award (see 4.3 and 6.4).

3.2 Item requirements. The individual item requirements shall be in accordance with MIL-PRF-38535 and as specified herein or as modified in the device manufacturer's Quality Management (QM) plan. The modification in the QM plan shall not affect the form, fit, or function as described herein.

3.3 Design, construction, and physical dimensions. The design, construction, and physical dimensions shall be as specified in MIL-PRF-38535 and herein.

3.3.1 Terminal connections and logic diagrams. The terminal connections and logic diagrams shall be as specified on figure 1.

3.3.2 Truth tables and logic equations. The truth tables and logic equations shall be as specified on figure 2.

3.3.3 Schematic circuits. The schematic circuits shall be maintained by the manufacturer and made available to the qualifying activity and the preparing activity upon request.

3.3.4 Case outlines. The case outlines shall be as specified in 1.2.3.

3.4 Lead material and finish. The lead material and finish shall be in accordance with MIL-PRF-38535 (see 6.6).

3.5 Electrical performance characteristics. The electrical performance characteristics are as specified in table I, and apply over the full recommended case operating temperature range, unless otherwise specified.

TABLE I. Electrical performance characteristics.

Test	Symbol	Conditions -55°C ≤ T_C ≤ +125°C	Device types	Limits Min	Limits Max	Unit
High level output voltage	V_{OH}	V_{CC} = 4.5 V, V_{IN} = 0.8 V, I_{OH} = -400 μA 1/	01, 02, 03, 04, 05	2.4	- - -	V
Low level output voltage	V_{OL}	V_{CC} = 4.5 V, I_{OL} = 16 mA, V_{IN} = 2.0 V for all inputs of gate under test 1/	All		0.4	V
Input clamp voltage	V_{IC}	V_{CC} = 4.5 V, I_{IN} = -12 mA T_C = 25°C	All		-1.5	V
Maximum collector cut-off current	I_{CEX}	V_{CC} = 4.5 V, V_{IN} = 0.8 V, V_{OH} = 5.5 V	06, 07 08, 09		250	μA
High level input current	I_{IH1}	V_{CC} = 5.5 V, V_{IN} = 2.4 V 2/	All		40	μA
High level input current	I_{IH2}	V_{CC} = 5.5 V, V_{IN} = 5.5 V 2/	All		100	μA
Low level input current	I_{IL}	V_{CC} = 5.5 V, V_{IN} = 0.4 V 1/	All	-0.7	-1.6	mA
Short circuit output current	I_{OS}	V_{CC} = 5.5 V 2/ 3/	01, 02, 03, 04, 05	-20	-55	mA
High level supply current per gate	I_{CCH}	V_{CC} = 5.5 V, V_{IN} = 0 V 2/	All		1.65	mA
Low level supply current per gate	I_{CCL}	V_{CC} = 5.5 V, V_{IN} = 5.5 V 1/	All		5.0	mA
Propagation delay time, high-to-low level	t_{PHL}	C_L = 50 pF, R_L = 390Ω	01, 02, 03, 04, 05	3	24	ns
			06, 07, 08, 09	3	29	ns
Propagation delay time, low-to-high level	t_{PLH}	C_L = 50 pF, R_L = 390Ω	01, 02, 03, 04, 05	3	27	ns
			06, 07, 08, 09	3	35	ns

1/   All unspecified inputs at 5.5 volts.
2/   All unspecified inputs grounded.
3/   Not more than one output should be shorted at a time.

3.6 Electrical test requirements. The electrical test requirements for each device class shall be the subgroups specified in table II. The electrical tests for each subgroup are described in table III.

TABLE II. Electrical test requirements.

MIL-PRF-38535 test requirements	Subgroups (see table III)	
	Class S devices	Class B devices
Interim electrical parameters	1	1
Final electrical test parameters	1*, 2, 3, 9 10, 11	1*, 2, 3, 9
Group A test requirements	1, 2, 3, 9, 10, 11	1, 2, 3, 9
Group B electrical test parameters when using the method 5005 QCI option	1, 2, 3, 9, 10, 11	N/A
Group C end-point electrical parameters	1, 2, 3, 9, 10, 11	1, 2, 3
Additional electrical parameters for group C periodic inspections	N/A	10, 11
Group D end-point electrical parameters	1, 2, 3	1, 2, 3

*PDA applies to subgroup 1.

3.7 Marking. Marking shall be in accordance with MIL-PRF-38535.

3.8 Microcircuit group assignment. The devices covered by this specification shall be in microcircuit group number 1 (see MIL-PRF-38535, appendix A).

4. VERIFICATION

4.1 Sampling and inspection. Sampling and inspection procedures shall be in accordance with MIL-PRF-38535 or as modified in the device manufacturer's Quality Management (QM) plan. The modification in the QM plan shall not affect the form, fit, or function as described herein.

4.2 Screening. Screening shall be in accordance with MIL-PRF-38535 and shall be conducted on all devices prior to qualification and conformance inspection. The following additional criteria shall apply:

a. The burn-in test duration, test condition, and test temperature, or approved alternatives shall be as specified in the device manufacturer's QM plan in accordance with MIL-PRF-38535. The burn-in test circuit shall be maintained under document control by the device manufacturer's Technology Review Board (TRB) in accordance with MIL-PRF-38535 and shall be made available to the acquiring or preparing activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1015 of MIL-STD-883.

b. Interim and final electrical test parameters shall be as specified in table II, except interim electrical parameters test prior to burn-in is optional at the discretion of the manufacturer.

c. Additional screening for space level product shall be as specified in MIL-PRF-38535, Appendix B.

4.3 <u>Qualification inspection.</u> Qualification inspection shall be in accordance with MIL-PRF-38535.

4.4 <u>Technology Conformance inspection (TCI)</u>. Technology conformance inspection shall be in accordance with MIL-PRF-38535 and herein for groups A, B, C, and D inspections (see 4.4.1 through 4.4.4).

4.4.1 <u>Group A inspection.</u> Group A inspection shall be in accordance with table III of MIL-PRF-3853<u>5</u> and as follows:

     a. Tests shall be as specified in table II herein.

     b. Subgroups 4, 5, 6, 7, and 8 shall be omitted.

4.4.2 <u>Group B inspection.</u> Group B inspection shall be in accordance with table II MIL-PRF-38535.

4.4.3 <u>Group C inspection.</u> Group C inspection shall be in accordance with table IV of MIL-PRF-38535 and as follows:

     a. End-point electrical parameters shall be as specified in table II herein.

     b. The steady-state life test duration, test condition, and test temperature, or approved alternatives shall be as specified in the device manufacturer's QM plan in accordance with MIL-PRF-38535. The burn-in test circuit shall be maintained under document control by the device manufacturer's Technology Review Board (TRB) in accordance with MIL-PRF-38535 and shall be made available to the acquiring or preparing activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1005 of MIL-STD-883.

4.4.4 <u>Group D inspection.</u> Group D inspection shall be in accordance with table V of MIL-PRF-38535. End-point electrical parameters shall be as specified in table II herein.

4.5 <u>Methods of inspection.</u> Methods of inspection shall be as specified and as follows:

4.5.1 <u>Voltage and current.</u> All voltages given are referenced to the microcircuit ground terminal. Currents given are conventional and positive when flowing into the referenced terminal.

DEVICE TYPE 01

CASES A,B, AND D   CASE C

DEVICE TYPE 02

CASES A,B, AND D   CASE C

DEVICE TYPE 03
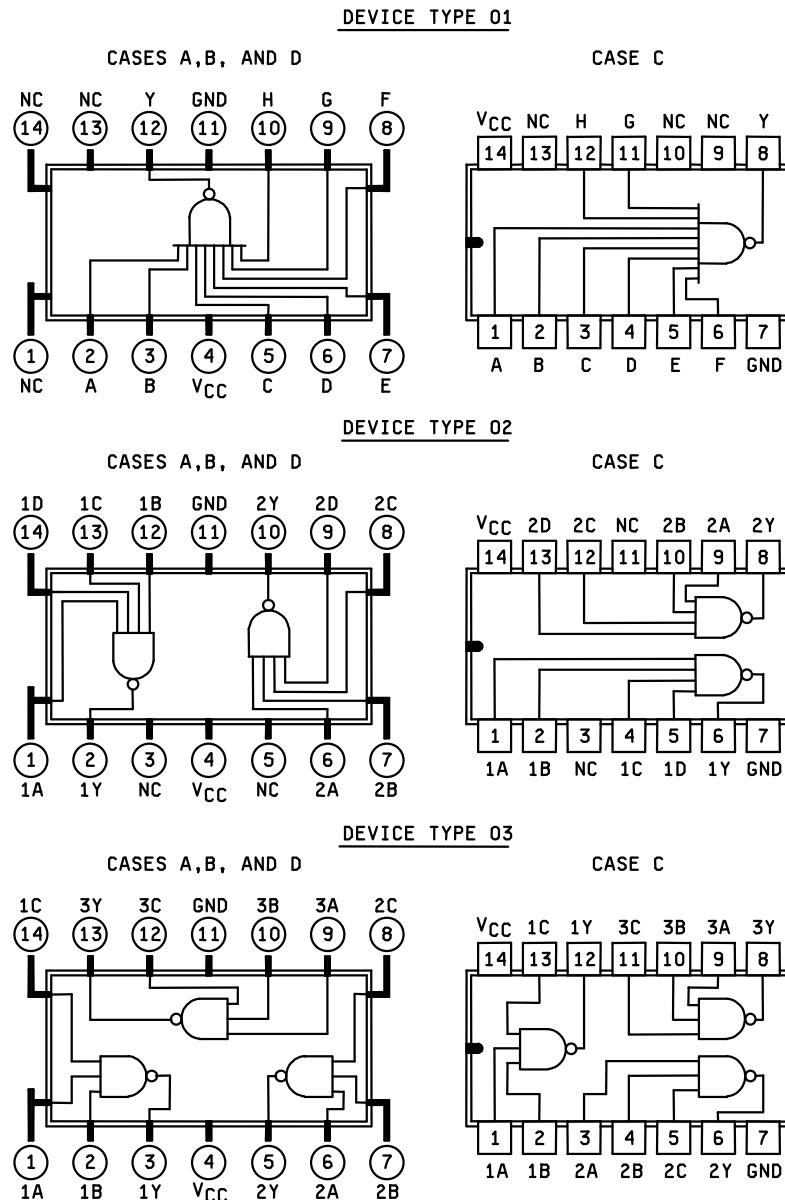
CASES A,B, AND D   CASE C

FIGURE 1. Terminal connections and logic diagrams.

DEVICE TYPE 04
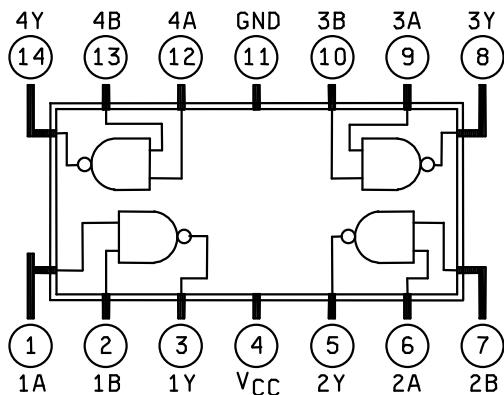
CASES A,B AND D   CASE C
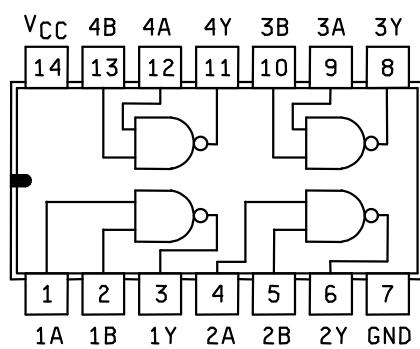
DEVICE TYPES 05 AND 08

CASES A,B AND D   CASE C
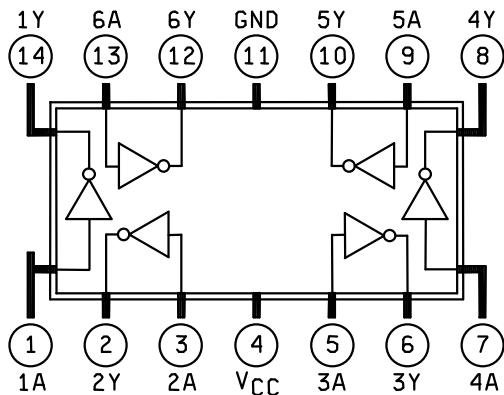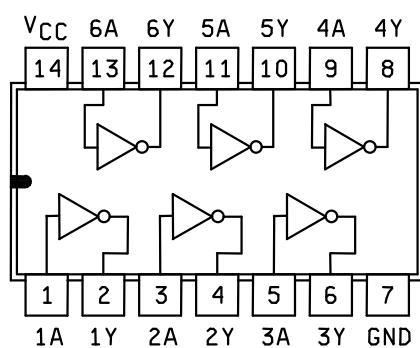
FIGURE 1. Terminal connections and logic diagrams - Continued.

DEVICE TYPE 06
CASES A,B,C AND D
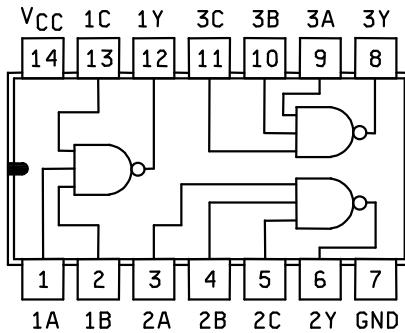
DEVICE TYPE 07

CASES A,B AND D   CASE C
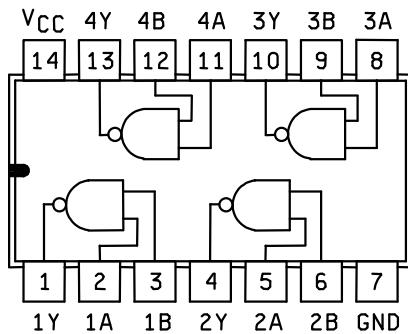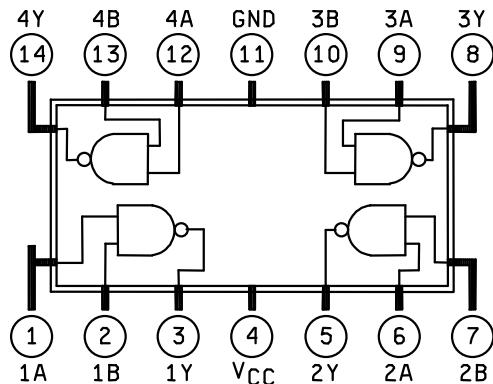
DEVICE TYPE 09
CASE C
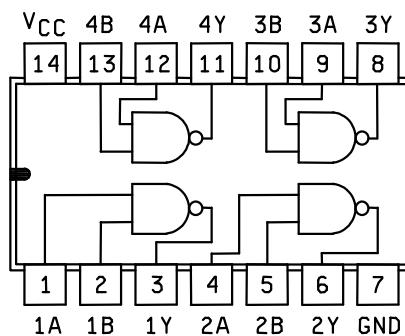
FIGURE 1. Terminal connections and logic diagrams - Continued.

Device type 01

	Truth table							
Input								Output
A	B	C	D	E	F	G	H	Y
H	H	H	H	H	H	H	H	L
All other combinations of H and L at the inputs give H output.								

Positive logic Y = $\overline{ABCDEFGH}$

Device types 03 and 06

	Truth table		
Input			Output
A	B	C	Y
L	L	L	H
H	L	L	H
L	H	L	H
H	H	L	H
L	L	H	H
H	L	H	H
L	H	H	H
H	H	H	L

Positive logic Y = $\overline{ABC}$

Device type 02

	Truth table			
Input				Output
A	B	C	D	Y
L	L	L	L	H
H	L	L	L	H
L	H	L	L	H
H	H	L	L	H
L	L	H	L	H
H	L	H	L	H
L	H	H	L	H
H	H	H	L	H
L	L	L	H	H
H	L	L	H	H
L	H	L	H	H
H	H	L	H	H
L	L	H	H	H
H	L	H	H	H
L	H	H	H	H
H	H	H	H	L

Positive logic Y = $\overline{ABCD}$

Device types 04, 07, and 09

Truth table each gate		
Input		Output
A	B	Y
L	L	H
H	L	H
L	H	H
H	H	L

Positive logic Y = $\overline{AB}$

Device types 05 and 08

Truth table each gate	
Input	Input
A	Y
L	H
H	L

Positive logic Y = $\overline{A}$

FIGURE 2. Truth tables and logic equations.

TEST CIRCUITS EXCEPT FOR OPEN COLLECTOR CIRCUITS
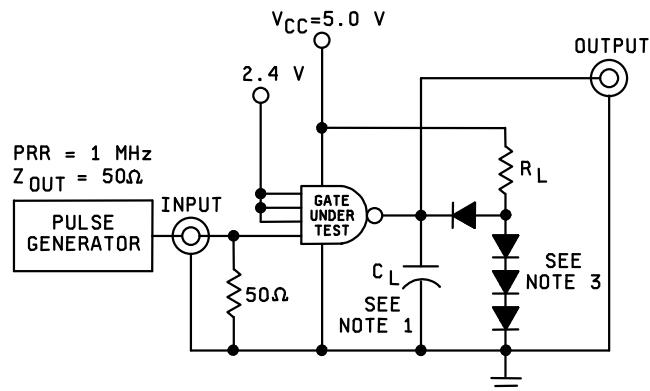
FOR OPEN COLLECTOR CIRCUITS
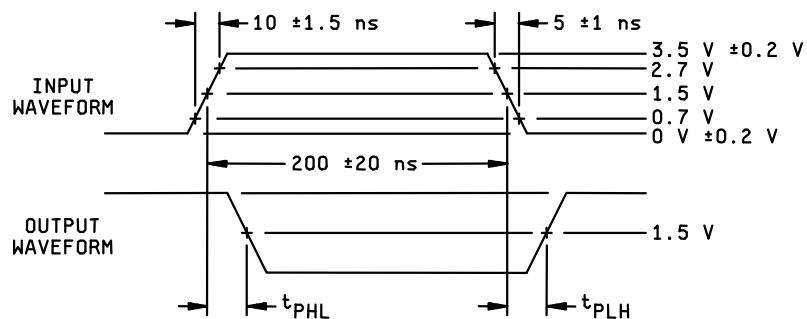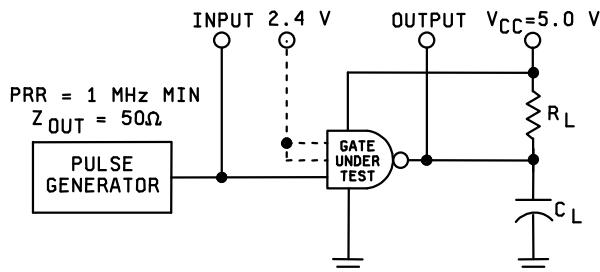
NOTES:
1. C_L = 50 pF minimum, including scope probe, wiring and stray capacitance, without package in test fixture.
2. Voltage measurements are to be made with respect to network ground terminal.
3. All diode are 1N3064 or equivalent.
4. R_L = 390 ohm ±5%.

FIGURE 3. Test circuit and switching waveforms.

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TABLE III. Group A inspection for device type 01.

Terminal conditions (pins not designated may be high ≥ 2.0 V, low ≤ 0.8 V or open)

Terminal column pin assignments (Cases A, B, D): A = 1, B = 2, Vcc = 14, C = 3, D = 4, E = 5, F = 6, G = 9, H = 10, GND = 11, Y = 12, NC = 13. (Case C package pin numbers differ.)

Subgroup	Symbol	MIL-STD-883 method	Test no.	A	B	Vcc	C	D	E	F	G	H	GND	Y	Measured terminal	Min	Max	Unit
1 (Tc = 25°C)	V_OL	3007	1	2.0 V	2.0 V	4.5 V	2.0 V	2.0 V	2.0 V	2.0 V	2.0 V	2.0 V	GND	16mA	Y		0.4	V
	V_OH	3006	2	0.8 V	5.5 V	4.5 V	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	GND	-4mA	Y	2.4		V
			3	5.5 V	0.8 V	4.5 V	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	GND	-4mA	Y	2.4		"
			4	5.5 V	5.5 V	4.5 V	0.8 V	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	GND	-4mA	Y	2.4		"
			5	5.5 V	5.5 V	4.5 V	5.5 V	0.8 V	5.5 V	5.5 V	5.5 V	5.5 V	GND	-4mA	Y	2.4		"
			6	5.5 V	5.5 V	4.5 V	5.5 V	5.5 V	0.8 V	5.5 V	5.5 V	5.5 V	GND	-4mA	Y	2.4		"
			7	5.5 V	5.5 V	4.5 V	5.5 V	5.5 V	5.5 V	0.8 V	5.5 V	5.5 V	GND	-4mA	Y	2.4		"
			8	5.5 V	5.5 V	4.5 V	5.5 V	5.5 V	5.5 V	5.5 V	0.8 V	5.5 V	GND	-4mA	Y	2.4		"
			9	5.5 V	5.5 V	4.5 V	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	0.8 V	GND	-4mA	Y	2.4		"
	I_OS	3011	10	GND	GND	5.5 V	GND	GND	GND	GND	GND	GND	GND	GND	Y	-20	-55	mA
	I_IH1	3010	11	2.4 V	GND	5.5 V	GND	GND	GND	GND	GND	GND	GND		A		40	μA
			12	GND	2.4 V	5.5 V	GND	GND	GND	GND	GND	GND	GND		B		40	"
			13	GND	GND	5.5 V	2.4 V	GND	GND	GND	GND	GND	GND		C		40	"
			14	GND	GND	5.5 V	GND	2.4 V	GND	GND	GND	GND	GND		D		40	"
			15	GND	GND	5.5 V	GND	GND	2.4 V	GND	GND	GND	GND		E		40	"
			16	GND	GND	5.5 V	GND	GND	GND	2.4 V	GND	GND	GND		F		40	"
			17	GND	GND	5.5 V	GND	GND	GND	GND	2.4 V	GND	GND		G		40	"
			18	GND	GND	5.5 V	GND	GND	GND	GND	GND	2.4 V	GND		H		40	"
	I_IH2	3010	19	5.5 V	GND	5.5 V	GND	GND	GND	GND	GND	GND	GND		A		100	μA
			20	GND	5.5 V	5.5 V	GND	GND	GND	GND	GND	GND	GND		B		100	"
			21	GND	GND	5.5 V	5.5 V	GND	GND	GND	GND	GND	GND		C		100	"
			22	GND	GND	5.5 V	GND	5.5 V	GND	GND	GND	GND	GND		D		100	"
			23	GND	GND	5.5 V	GND	GND	5.5 V	GND	GND	GND	GND		E		100	"
			24	GND	GND	5.5 V	GND	GND	GND	5.5 V	GND	GND	GND		F		100	"
			25	GND	GND	5.5 V	GND	GND	GND	GND	5.5 V	GND	GND		G		100	"
			26	GND	GND	5.5 V	GND	GND	GND	GND	GND	5.5 V	GND		H		100	"
	I_IL	3009	27	0.4 V	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	GND		A	-0.7	-1.6	mA
			28	5.5 V	0.4 V	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	GND		B	-0.7	-1.6	"
			29	5.5 V	5.5 V	5.5 V	0.4 V	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	GND		C	-0.7	-1.6	"
			30	5.5 V	5.5 V	5.5 V	5.5 V	0.4 V	5.5 V	5.5 V	5.5 V	5.5 V	GND		D	-0.7	-1.6	"
			31	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	0.4 V	5.5 V	5.5 V	5.5 V	GND		E	-0.7	-1.6	"
			32	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	0.4 V	5.5 V	5.5 V	GND		F	-0.7	-1.6	"
			33	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	0.4 V	5.5 V	GND		G	-0.7	-1.6	"
			34	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	0.4 V	GND		H	-0.7	-1.6	"
	I_CCL	3005	35	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	GND		V_CC		5.0	mA
	I_CCH	3005	36	GND	GND	5.5 V	GND	GND	GND	GND	GND	GND	GND		V_CC		1.65	mA
	V_IC		37	-12 mA		4.5 V							GND		A	-1.5		V
			38		-12 mA	4.5 V							GND		B	-1.5		"
			39			4.5 V	-12 mA						GND		C	-1.5		"
			40			4.5 V		-12 mA					GND		D	-1.5		"
			41			4.5 V			-12 mA				GND		E	-1.5		"
			42			4.5 V				-12 mA			GND		F	-1.5		"
			43			4.5 V					-12 mA		GND		G	-1.5		"
			44			4.5 V						-12 mA	GND		H	-1.5		"
2	Same tests, terminal conditions and limits as for subgroup 1, except Tc = 125°C and V_IC tests are omitted.																	
3	Same tests, terminal conditions and limits as for subgroup 1, except Tc = -55°C and V_IC tests are omitted.																	
9 (Tc = 25°C)	t_PHL	3003 (Fig. 3)	45	IN	2.4 V	5.0 V	2.4 V	2.4 V	2.4 V	2.4 V	2.4 V	2.4 V	GND	OUT	A to Y	3	20	ns
	t_PLH	(Fig. 3)	46	IN	2.4 V	5.0 V	2.4 V	2.4 V	2.4 V	2.4 V	2.4 V	2.4 V	GND	OUT	A to Y	3	25	ns
10 (Tc = 125°C)	t_PHL	3003	47	IN	2.4 V	5.0 V	2.4 V	2.4 V	2.4 V	2.4 V	2.4 V	2.4 V	GND	OUT	A to Y	3	24	ns
	t_PLH	(Fig. 3)	48	IN	2.4 V	5.0 V	2.4 V	2.4 V	2.4 V	2.4 V	2.4 V	2.4 V	GND	OUT	A to Y	3	27	ns
11	Same tests, terminal conditions and limits as for subgroup 10, except Tc = -55°C.																	

TABLE III. Group A inspection for device type 02.

Terminal conditions (pins not designated may be high ≥ 2.0 V, low ≤ 0.8 V or open)

Pin numbers — Cases A, B, D: 1A=1, 1Y=2, NC=3, Vcc=4, NC=5, 2A=6, 2B=7, 2C=8, 2D=9, 2Y=10, GND=11, 1B=12, 1C=13, 1D=14.
Pin numbers — Case C: 1A=1, 1Y=6, NC=3, Vcc=14, NC=11, 2A=9, 2B=10, 2C=12, 2D=13, 2Y=8, GND=7, 1B=2, 1C=4, 1D=5.

Subgroup	Symbol	MIL-STD-883 method	Test no.	1A	1Y	NC	Vcc	NC	2A	2B	2C	2D	2Y	GND	1B	1C	1D	Measured terminal	Min	Max	Unit
1 (Tc = 25°C)	V_{OL}	3007	1	2.0 V	16 mA		4.5 V		5.5 V	5.5 V	5.5 V	5.5 V		GND	2.0 V	2.0 V	2.0 V	1Y		0.4	V
			2	5.5 V			4.5 V		2.0 V	2.0 V	2.0 V	2.0 V	16 mA	GND	5.5 V	5.5 V	5.5 V	2Y		0.4	V
	V_{OH}	3006	3	0.8 V	-4 mA		4.5 V		5.5 V	5.5 V	5.5 V	5.5 V		GND	5.5 V	5.5 V	5.5 V	1Y	2.4		V
			4	5.5 V	-4 mA		4.5 V		5.5 V	5.5 V	5.5 V	5.5 V		GND	0.8 V	5.5 V	5.5 V	1Y	2.4		V
			5	5.5 V	-4 mA		4.5 V		5.5 V	5.5 V	5.5 V	5.5 V		GND	5.5 V	0.8 V	5.5 V	1Y	2.4		V
			6	5.5 V	-4 mA		4.5 V		5.5 V	5.5 V	5.5 V	5.5 V		GND	5.5 V	5.5 V	0.8 V	1Y	2.4		V
			7	5.5 V			4.5 V		0.8 V	5.5 V	5.5 V	5.5 V	-4 mA	GND	5.5 V	5.5 V	5.5 V	2Y	2.4		V
			8	5.5 V			4.5 V		5.5 V	0.8 V	5.5 V	5.5 V	-4 mA	GND	5.5 V	5.5 V	5.5 V	2Y	2.4		V
			9	5.5 V			4.5 V		5.5 V	5.5 V	0.8 V	5.5 V	-4 mA	GND	5.5 V	5.5 V	5.5 V	2Y	2.4		V
			10	5.5 V			4.5 V		5.5 V	5.5 V	5.5 V	0.8 V	-4 mA	GND	5.5 V	5.5 V	5.5 V	2Y	2.4		V
	I_{OS}	3011	11	GND	GND		5.5 V		GND	GND	GND	GND		GND	GND	GND	GND	1Y	-20	-55	mA
			12	GND			5.5 V		GND	GND	GND	GND	GND	GND	GND	GND	GND	2Y	-20	-55	mA
	I_{IH1}	3010	13	2.4 V			5.5 V		GND	GND	GND	GND		GND	GND	GND	GND	1A		40	µA
			14	GND			5.5 V		GND	GND	GND	GND		GND	2.4 V	GND	GND	1B		40	µA
			15	GND			5.5 V		GND	GND	GND	GND		GND	GND	2.4 V	GND	1C		40	µA
			16	GND			5.5 V		GND	GND	GND	GND		GND	GND	GND	2.4 V	1D		40	µA
			17	GND			5.5 V		2.4 V	GND	GND	GND		GND	GND	GND	GND	2A		40	µA
			18	GND			5.5 V		GND	2.4 V	GND	GND		GND	GND	GND	GND	2B		40	µA
			19	GND			5.5 V		GND	GND	2.4 V	GND		GND	GND	GND	GND	2C		40	µA
			20	GND			5.5 V		GND	GND	GND	2.4 V		GND	GND	GND	GND	2D		40	µA
	I_{IH2}	3010	21	5.5 V			5.5 V		GND	GND	GND	GND		GND	GND	GND	GND	1A		100	µA
			22	GND			5.5 V		GND	GND	GND	GND		GND	5.5 V	GND	GND	1B		100	µA
			23	GND			5.5 V		GND	GND	GND	GND		GND	GND	5.5 V	GND	1C		100	µA
			24	GND			5.5 V		GND	GND	GND	GND		GND	GND	GND	5.5 V	1D		100	µA
			25	GND			5.5 V		5.5 V	GND	GND	GND		GND	GND	GND	GND	2A		100	µA
			26	GND			5.5 V		GND	5.5 V	GND	GND		GND	GND	GND	GND	2B		100	µA
			27	GND			5.5 V		GND	GND	5.5 V	GND		GND	GND	GND	GND	2C		100	µA
			28	GND			5.5 V		GND	GND	GND	5.5 V		GND	GND	GND	GND	2D		100	µA
	I_{IL}	3009	29	0.4 V			5.5 V		5.5 V	5.5 V	5.5 V	5.5 V		GND	5.5 V	5.5 V	5.5 V	1A	-0.7	-1.6	mA
			30	5.5 V			5.5 V		5.5 V	5.5 V	5.5 V	5.5 V		GND	0.4 V	5.5 V	5.5 V	1B	-0.7	-1.6	mA
			31	5.5 V			5.5 V		5.5 V	5.5 V	5.5 V	5.5 V		GND	5.5 V	0.4 V	5.5 V	1C	-0.7	-1.6	mA
			32	5.5 V			5.5 V		5.5 V	5.5 V	5.5 V	5.5 V		GND	5.5 V	5.5 V	0.4 V	1D	-0.7	-1.6	mA
			33	5.5 V			5.5 V		0.4 V	5.5 V	5.5 V	5.5 V		GND	5.5 V	5.5 V	5.5 V	2A	-0.7	-1.6	mA
			34	5.5 V			5.5 V		5.5 V	0.4 V	5.5 V	5.5 V		GND	5.5 V	5.5 V	5.5 V	2B	-0.7	-1.6	mA
			35	5.5 V			5.5 V		5.5 V	5.5 V	0.4 V	5.5 V		GND	5.5 V	5.5 V	5.5 V	2C	-0.7	-1.6	mA
			36	5.5 V			5.5 V		5.5 V	5.5 V	5.5 V	0.4 V		GND	5.5 V	5.5 V	5.5 V	2D	-0.7	-1.6	mA
	I_{CCL}	3005	37	5.5 V			5.5 V		5.5 V	5.5 V	5.5 V	5.5 V		GND	5.5 V	5.5 V	5.5 V	Vcc		10	mA
	I_{CCH}	3005	38	GND			5.5 V		GND	GND	GND	GND		GND	GND	GND	GND	Vcc		3.3	mA
	V_{IC}		39	-12 mA			4.5 V											1A		-1.5	V
			40				4.5 V								-12 mA			1B		-1.5	V
			41				4.5 V									-12 mA		1C		-1.5	V
			42				4.5 V										-12 mA	1D		-1.5	V
			43				4.5 V		-12 mA									2A		-1.5	V
			44				4.5 V			-12 mA								2B		-1.5	V
			45				4.5 V				-12 mA							2C		-1.5	V
			46				4.5 V					-12 mA						2D		-1.5	V

2 — Same tests, terminal conditions and limits as for subgroup 1, except Tc = 125°C and V_{IC} tests are omitted.

3 — Same tests, terminal conditions and limits as for subgroup 1, except Tc = -55°C and V_{IC} tests are omitted.

Subgroup	Symbol	MIL-STD-883 method	Test no.	1A	1Y	NC	Vcc	NC	2A	2B	2C	2D	2Y	GND	1B	1C	1D	Measured terminal	Min	Max	Unit
9 (Tc = 25°C)	t_{PHL} / t_{PLH}	3003 (Fig. 3)	47	IN	OUT		5.0 V		IN	2.4 V	2.4 V	2.4 V	OUT	GND	2.4 V	2.4 V	2.4 V	1A to 1Y	3	20	ns
			48	IN	OUT		5.0 V		IN	2.4 V	2.4 V	2.4 V	OUT	GND	2.4 V	2.4 V	2.4 V	2A to 2Y	3	20	ns
	t_{PLH} / t_{PHL}	3003 (Fig. 3)	49	IN	OUT		5.0 V		IN	2.4 V	2.4 V	2.4 V	OUT	GND	2.4 V	2.4 V	2.4 V	1A to 1Y	3	25	ns
			50	IN	OUT		5.0 V		IN	2.4 V	2.4 V	2.4 V	OUT	GND	2.4 V	2.4 V	2.4 V	2A to 2Y	3	25	ns
10 (Tc = 125°C)	t_{PHL} / t_{PLH}	3003 (Fig. 3)	51	IN	OUT		5.0 V		IN	2.4 V	2.4 V	2.4 V	OUT	GND	2.4 V	2.4 V	2.4 V	1A to 1Y	3	24	ns
			52	IN	OUT		5.0 V		IN	2.4 V	2.4 V	2.4 V	OUT	GND	2.4 V	2.4 V	2.4 V	2A to 2Y	3	24	ns
	t_{PLH} / t_{PHL}	3003 (Fig. 3)	53	IN	OUT		5.0 V		IN	2.4 V	2.4 V	2.4 V	OUT	GND	2.4 V	2.4 V	2.4 V	1A to 1Y	3	27	ns
			54	IN	OUT		5.0 V		IN	2.4 V	2.4 V	2.4 V	OUT	GND	2.4 V	2.4 V	2.4 V	2A to 2Y	3	27	ns

11 — Same tests, terminal conditions and limits as for subgroup 10, except Tc = -55°C.

TABLE III. Group A inspection for device type 03.

Terminal conditions (pins not designated may be high ≥ 2.0 V, low ≤ 0.8 V or open)

Terminal-condition column headers — Cases A, B, D pin no. / Case C pin no. / pin name:

Cases A,B,D	1	2	3	4	5	6	7	8	9	10	11	12	13	14
Case C	1	2	12	14	6	3	4	5	9	10	7	11	8	13
Pin	1A	1B	1Y	Vcc	2Y	2A	2B	2C	3A	3B	GND	3C	3Y	1C

Subgroup	Symbol	MIL-STD-883 method	Test no.	1 (1A)	2 (1B)	3 (1Y)	4 (Vcc)	5 (2Y)	6 (2A)	7 (2B)	8 (2C)	9 (3A)	10 (3B)	11 (GND)	12 (3C)	13 (3Y)	14 (1C)	Measured terminal	Min	Max	Unit
1 Tc = 25°C	V_OL	3007	1	2.0 V	2.0 V	16 mA	4.5 V		5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	GND	5.5 V		2.0 V	1Y		0.4	V
			2	5.5 V	5.5 V		4.5 V	16 mA	2.0 V	2.0 V	2.0 V	5.5 V	5.5 V	GND	5.5 V		5.5 V	2Y		"	"
			3	5.5 V	5.5 V		4.5 V		5.5 V	5.5 V	5.5 V	2.0 V	2.0 V	GND	2.0 V	16 mA	5.5 V	3Y			
	V_OH	3006	4	0.8 V	5.5 V	-4 mA	4.5 V		5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	GND	5.5 V		5.5 V	1Y	2.4		V
			5	5.5 V	0.8 V	-4 mA	"		"	"	"	"	"	GND	"		5.5 V	1Y	"		"
			6	5.5 V	5.5 V	-4 mA	"		"	"	"	"	"	GND	"		0.8 V	1Y	"		"
			7	"	"		"	-4 mA	0.8 V	5.5 V	5.5 V	"	"	GND	"		"	2Y	"		"
			8	"	"		"	-4 mA	5.5 V	0.8 V	5.5 V	"	"	GND	"		"	2Y	"		"
			9	"	"		"	-4 mA	5.5 V	5.5 V	0.8 V	"	"	GND	"		"	2Y	"		"
			10	"	"		"		"	"	"	0.8 V	5.5 V	GND	5.5 V	-4 mA	"	3Y	"		"
			11	"	"		"		"	"	"	5.5 V	0.8 V	GND	5.5 V	-4 mA	"	3Y	"		"
			12	"	"		0.8 V		"	"	"	5.5 V	5.5 V	GND	0.8 V	"	"	3Y	"		"
	I_OS	3011	13	GND	GND	GND	5.5 V							GND			GND	1Y	-20	-55	mA
			14	"	"		"	GND	GND	GND	GND			GND			"	2Y	"	"	"
			15	"	"		"					GND	GND	GND	GND	GND	"	3Y			
	I_IH1	3010	16	2.4 V	GND	GND	5.5 V		GND	GND	GND	GND	GND	GND	GND		GND	1A		40	µA
			17	GND	2.4 V	GND	"		"	"	"	"	"	GND	"		"	1B		"	"
			18	"	GND	"	"		"	"	"	"	"	GND	"		2.4 V	1C		"	"
			19	"	"	"	"		2.4 V	"	"	"	"	GND	"		GND	2A		"	"
			20	"	"	"	"		GND	2.4 V	"	"	"	GND	"		"	2B		"	"
			21	"	"	"	"		"	GND	2.4 V	"	"	GND	"		"	2C		"	"
			22	"	"	"	"		"	"	GND	2.4 V	"	GND	"		"	3A		"	"
			23	"	"	"	"		"	"	"	GND	2.4 V	GND	"		"	3B		"	"
			24	"	"	"	"		"	"	"	"	GND	GND	2.4 V		"	3C			
	I_IH2	3010	25	5.5 V	GND	GND	5.5 V		GND	GND	GND	GND	GND	GND	GND		GND	1A		100	µA
			26	GND	5.5 V	"	"		"	"	"	"	"	GND	"		"	1B		"	"
			27	"	GND	"	"		"	"	"	"	"	GND	"		5.5 V	1C		"	"
			28	"	"	"	"		5.5 V	"	"	"	"	GND	"		GND	2A		"	"
			29	"	"	"	"		GND	5.5 V	"	"	"	GND	"		"	2B		"	"
			30	"	"	"	"		"	GND	5.5 V	"	"	GND	"		"	2C		"	"
			31	"	"	"	"		"	"	GND	5.5 V	"	GND	2.4 V		"	3A		"	"
			32	"	"	"	"		"	"	"	GND	5.5 V	GND	"		"	3B		"	"
			33	"	"	"	"		"	"	"	"	GND	GND	5.5 V		"	3C			
	I_IL	3009	34	0.4 V	5.5 V	5.5 V	5.5 V		5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	GND	5.5 V		5.5 V	1A	-0.7	-1.6	mA
			35	5.5 V	0.4 V	"	"		"	"	"	"	"	GND	"		"	1B	"	"	"
			36	"	5.5 V	"	"		"	"	"	"	"	GND	"		0.4 V	1C	"	"	"
			37	"	"	"	"		0.4 V	"	"	"	"	GND	"		5.5 V	2A	"	"	"
			38	"	"	"	"		5.5 V	0.4 V	"	"	"	GND	"		"	2B	"	"	"
			39	"	"	"	"		5.5 V	5.5 V	0.4 V	"	"	GND	"		"	2C	"	"	"
			40	"	"	"	"		"	"	"	0.4 V	5.5 V	GND	5.5 V		"	3A	"	"	"
			41	"	"	"	"		"	"	"	5.5 V	0.4 V	GND	5.5 V		"	3B	"	"	"
			42	"	"	"	0.4 V		"	"	"	5.5 V	5.5 V	GND	0.4 V		"	3C			
	I_CCH	3005	43	GND	GND	GND	5.5 V		GND	GND	GND	GND	GND	GND	GND		GND	Vcc		4.95	mA
	I_CCL	3005	44	5.5 V	5.5 V	5.5 V	5.5 V		5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	GND	5.5 V		5.5 V	Vcc		15	mA
	V_IC		45	-12 mA			4.5 V							GND				1A		-1.5	V
			46		-12mA		"							GND				1B		"	"
			47				"							GND			-12 mA	1C		"	"
			48				"		-12 mA					GND				2A		"	"
			49				"			-12 mA				GND				2B		"	"
			50				"				-12 mA			GND				2C		"	"
			51				"					-12 mA		GND				3A		"	"
			52				"						-12 mA	GND				3B		"	"
			53				"							GND	-12 mA			3C			
2	Same tests, terminal conditions and limits as for subgroup 1, except Tc = 125°C and V_IC tests are omitted.																				
3	Same tests, terminal conditions and limits as for subgroup 1, except Tc = -55°C and V_IC tests are omitted.																				

TABLE III. Group A inspection for device type 03 - Continued.

Terminal conditions (pins not designated may be high ≥ 2.0 V, low ≤ 0.8 V or open).

Subgroup	Symbol	MIL-STD-883 method	Cases A, B, D Case C Test no.	1 1A	2 1B	3 1Y	4 Vcc	5 2Y	6 2A	7 2B	8 2C	9 3A	10 3B	11 GND	12 3C	13 3Y	14 1C	Measured terminal	Min	Max	Unit
9 Tc = 25°C	t_{PHL}	3003 (Fig. 3)	54	IN	2.4 V	OUT	5.0 V							GND			2.4 V	1A to 1Y	3	20	ns
			55				"	OUT	IN	2.4 V	2.4 V			"				2A to 2Y	"	"	"
			56				"					IN	2.4 V	"	2.4 V	OUT		3A to 3Y	"	"	"
	t_{PLH}	3003 (Fig. 3)	57	IN	2.4 V	OUT	5.0 V							GND			2.4 V	1A to 1Y	3	25	ns
			58				"	OUT	IN	2.4 V	2.4 V			"				2A to 2Y	"	"	"
			59				"					IN	2.4 V	"	2.4 V	OUT		3A to 3Y	"	"	"
10 Tc = 125°C	t_{PHL}	3003 (Fig. 3)	60	IN	2.4 V	OUT	5.0 V							GND			2.4 V	1A to 1Y	3	24	ns
			61				"	OUT	IN	2.4 V	2.4 V			"				2A to 2Y	"	"	"
			62				"					IN	2.4 V	"	2.4 V	OUT		3A to 3Y	"	"	"
	t_{PLH}	3003 (Fig. 3)	63	IN	2.4 V	OUT	5.0 V							GND			2.4 V	1A to 1Y	3	27	ns
			64				"	OUT	IN	2.4 V	2.4 V			"				2A to 2Y	"	"	"
			65				"					IN	2.4 V	"	2.4 V	OUT		3A to 3Y	"	"	"
11	Same tests, terminal conditions and limits as for subgroup 10, except Tc = -55°C.																				

TABLE III. Group A inspection for device type 04.

Terminal conditions (pins not designated may be high ≥ 2.0 V, low ≤ 0.8 V or open)

Subgroup	Symbol	MIL-STD-883 method	Test no. (Cases A,B,D / Case C)	1 1A	2 1B	3 1Y	4 Vcc	5 2Y	6 2A	7 2B	8 3Y	9 3A	10 3B	11 GND	12 4A	13 4B	14 4Y	Measured terminal	Min	Max	Unit
1 Tc = 25°C	V_{OL}	3007	1	2.0 V	2.0 V	16 mA	4.5 V		5.5 V	5.5 V		5.5 V	5.5 V	GND	5.5 V	5.5 V		1Y		0.4	V
			2	5.5 V	5.5 V		4.5 V	16 mA	2.0 V	2.0 V		5.5 V	5.5 V	GND	5.5 V	5.5 V		2Y		"	"
			3	5.5 V	5.5 V		4.5 V		5.5 V	5.5 V	16 mA	2.0 V	2.0 V	GND	5.5 V	5.5 V		3Y		"	"
			4	5.5 V	5.5 V		4.5 V		5.5 V	5.5 V		5.5 V	5.5 V	GND	2.0 V	2.0 V	16 mA	4Y		"	"
	V_{OH}	3006	5	0.8 V	5.5 V	-4 mA	4.5 V							GND				1Y	2.4		V
			6	5.5 V	0.8 V	-4 mA	4.5 V							GND				1Y	"		"
			7				4.5 V	-4 mA	0.8 V	5.5 V				GND				2Y	"		"
			8				4.5 V	-4 mA	5.5 V	0.8 V				GND				2Y	"		"
			9				4.5 V				-4 mA	0.8 V	5.5 V	GND				3Y	"		"
			10				4.5 V				-4 mA	5.5 V	0.8 V	GND				3Y	"		"
			11				4.5 V							GND	0.8 V	5.5 V	-4 mA	4Y	"		"
			12				4.5 V							GND	5.5 V	0.8 V	-4 mA	4Y	"		"
	I_{OS}	3011	13	GND	GND	GND	5.5 V							GND				1Y	-20	-55	mA
			14				5.5 V	GND	GND	GND				GND				2Y	"	"	"
			15				5.5 V				GND	GND	GND	GND				3Y	"	"	"
			16				5.5 V							GND	GND	GND	GND	4Y	"	"	"
	I_{IH1}	3010	17	2.4 V	GND		5.5 V							GND				1A		40	µA
			18	GND	2.4 V		5.5 V							GND				1B		"	"
			19				5.5 V		2.4 V	GND				GND				2A		"	"
			20				5.5 V		GND	2.4 V				GND				2B		"	"
			21				5.5 V					2.4 V	GND	GND				3A		"	"
			22				5.5 V					GND	2.4 V	GND				3B		"	"
			23				5.5 V							GND	2.4 V	GND		4A		"	"
			24				5.5 V							GND	GND	2.4 V		4B		"	"
	I_{IH2}	3010	25	5.5 V	GND		5.5 V							GND				1A		100	µA
			26	GND	5.5 V		5.5 V							GND				1B		"	"
			27				5.5 V		5.5 V	GND				GND				2A		"	"
			28				5.5 V		GND	5.5 V				GND				2B		"	"
			29				5.5 V					5.5 V	GND	GND				3A		"	"
			30				5.5 V					GND	5.5 V	GND				3B		"	"
			31				5.5 V							GND	5.5 V	GND		4A		"	"
			32				5.5 V							GND	GND	5.5 V		4B		"	"
	I_{IL}	3009	33	0.4 V	5.5 V		5.5 V							GND				1A	-0.7	-1.6	mA
			34	5.5 V	0.4 V		5.5 V							GND				1B	"	"	"
			35				5.5 V		0.4 V	5.5 V				GND				2A	"	"	"
			36				5.5 V		5.5 V	0.4 V				GND				2B	"	"	"
			37				5.5 V					0.4 V	5.5 V	GND				3A	"	"	"
			38				5.5 V					5.5 V	0.4 V	GND				3B	"	"	"
			39				5.5 V							GND	0.4 V	5.5 V		4A	"	"	"
			40				5.5 V							GND	5.5 V	0.4 V		4B	"	"	"
	I_{CCH}	3005	41	GND	GND		5.5 V		GND	GND		GND	GND	GND	GND	GND		Vcc		6.6	mA
	I_{CCL}	3005	42	5.5 V	5.5 V		5.5 V		5.5 V	5.5 V		5.5 V	5.5 V	GND	5.5 V	5.5 V		Vcc		20	mA
	V_{IC}		43	-12 mA			4.5 V							GND				1A		-1.5	V
			44		-12 mA		"							"				1B		"	"
			45				"		-12 mA					"				2A		"	"
			46				"			-12 mA				"				2B		"	"
			47				"					-12 mA		"				3A		"	"
			48				"						-12 mA	"				3B		"	"
			49				"							"	-12 mA			4A		"	"
			50				"							"		-12 mA		4B		"	"
2	Same tests, terminal conditions and limits as for subgroup 1, except Tc = 125°C and V_{IC} tests are omitted.																				
3	Same tests, terminal conditions and limits as for subgroup 1, except Tc = -55°C and V_{IC} tests are omitted.																				

TABLE III. Group A inspection for device type 04 - Continued.

Terminal conditions (pins not designated may be high ≥ 2.0 V, low ≤ 0.8 V or open).

Subgroup	Symbol	MIL-STD-883 method	Cases A, B, D / Case C Test no.	1 (1A)	2 (1B)	3 (1Y)	4 (V_{CC})	5 (2Y)	6 (2A)	7 (2B)	8 (3Y)	9 (3A)	10 (3B)	11 (GND)	12 (4A)	13 (4B)	14 (4Y)	Measured terminal	Min	Max	Unit
9 Tc = 25°C	t_{PHL}	3003 (Fig. 3)	51 52 53 54	IN	2.4 V	OUT	5.0 V	OUT	IN	2.4 V	OUT	IN	2.4 V	GND				1A to 1Y / 2A to 2Y / 3A to 3Y / 4A to 4Y	3	20	ns
	t_{PLH}	3003 (Fig. 3)	55 56 57 58	IN	2.4 V	OUT	5.0 V	OUT	IN	2.4 V	OUT	IN	2.4 V	GND	IN	2.4 V	OUT	1A to 1Y / 2A to 2Y / 3A to 3Y / 4A to 4Y	3	25	ns
10 Tc = 125°C	t_{PHL}	3003 (Fig. 3)	59 60 61 62	IN	2.4 V	OUT	5.0 V	OUT	IN	2.4 V	OUT	IN	2.4 V	GND	IN	2.4 V	OUT	1A to 1Y / 2A to 2Y / 3A to 3Y / 4A to 4Y	3	24	ns
	t_{PLH}	3003 (Fig. 3)	63 64 65 66	IN	2.4 V	OUT	5.0 V	OUT	IN	2.4 V	OUT	IN	2.4 V	GND	IN	2.4 V	OUT	1A to 1Y / 2A to 2Y / 3A to 3Y / 4A to 4Y	3	27	ns
11	Same tests, terminal conditions and limits as for subgroup 10, except Tc = -55°C.																				

TABLE III. Group A inspection for device type 05.

Terminal conditions (pins not designated may be high ≥ 2.0 V, low ≤ 0.8 V or open)

			Terminal / pin (col no.)															Limits		
Subgroup	Symbol	MIL-STD-883 method	Test no. (Cases A,B,D / Case C)	1 · 1A	2 · 2Y	3 · 2A	4 · V_CC	5 · 3A	6 · 3Y	7 · 4A	8 · 4Y	9 · 5A	10 · 5Y	11 · GND	12 · 6Y	13 · 6A	14 · 1Y	Measured terminal	Min	Max	Unit
1 Tc = 25°C	V_OL	3007	1	2.0 V	16 mA	5.5 V	4.5 V	5.5 V	16 mA	5.5 V	16 mA	5.5 V	16 mA	GND	16 mA	5.5 V	16 mA	1Y		0.4	V
			2	5.5 V	16 mA	2.0 V	4.5 V	5.5 V	16 mA	5.5 V	16 mA	5.5 V	16 mA	GND	16 mA	5.5 V	16 mA	2Y		"	"
			3	5.5 V	16 mA	5.5 V	4.5 V	2.0 V	16 mA	5.5 V	16 mA	5.5 V	16 mA	GND	16 mA	5.5 V	16 mA	3Y		"	"
			4	5.5 V	16 mA	5.5 V	4.5 V	5.5 V	16 mA	2.0 V	16 mA	5.5 V	16 mA	GND	16 mA	5.5 V	16 mA	4Y		"	"
			5	5.5 V	16 mA	5.5 V	4.5 V	5.5 V	16 mA	5.5 V	16 mA	2.0 V	16 mA	GND	16 mA	5.5 V	16 mA	5Y		"	"
			6	5.5 V	16 mA	5.5 V	4.5 V	5.5 V	16 mA	5.5 V	16 mA	5.5 V	16 mA	GND	16 mA	2.0 V	16 mA	6Y		"	"
	V_OH	3006	7	0.8 V	-.4 mA	5.5 V	4.5 V	5.5 V	-.4 mA	5.5 V	-.4 mA	5.5 V	-.4 mA	GND	-.4 mA	5.5 V	-.4 mA	1Y	2.4		V
			8	5.5 V	-.4 mA	0.8 V	4.5 V	5.5 V	-.4 mA	5.5 V	-.4 mA	5.5 V	-.4 mA	GND	-.4 mA	5.5 V	-.4 mA	2Y	"		"
			9	5.5 V	-.4 mA	5.5 V	4.5 V	0.8 V	-.4 mA	5.5 V	-.4 mA	5.5 V	-.4 mA	GND	-.4 mA	5.5 V	-.4 mA	3Y	"		"
			10	5.5 V	-.4 mA	5.5 V	4.5 V	5.5 V	-.4 mA	0.8 V	-.4 mA	5.5 V	-.4 mA	GND	-.4 mA	5.5 V	-.4 mA	4Y	"		"
			11	5.5 V	-.4 mA	5.5 V	4.5 V	5.5 V	-.4 mA	5.5 V	-.4 mA	0.8 V	-.4 mA	GND	-.4 mA	5.5 V	-.4 mA	5Y	"		"
			12	5.5 V	-.4 mA	5.5 V	4.5 V	5.5 V	-.4 mA	5.5 V	-.4 mA	5.5 V	-.4 mA	GND	-.4 mA	0.8 V	-.4 mA	6Y	"		"
	I_OS	3011	13	GND	GND	GND	5.5 V	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	1Y	-20	-55	mA
			14	GND	GND	GND	5.5 V	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	2Y	"	"	"
			15	GND	GND	GND	5.5 V	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	3Y	"	"	"
			16	GND	GND	GND	5.5 V	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	4Y	"	"	"
			17	GND	GND	GND	5.5 V	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	5Y	"	"	"
			18	GND	GND	GND	5.5 V	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	6Y	"	"	"
	I_IH1	3010	19	2.4 V		GND	5.5 V	GND		GND		GND		GND		GND		1A		40	µA
			20	GND		2.4 V	5.5 V	GND		GND		GND		GND		GND		2A		"	"
			21	GND		GND	5.5 V	2.4 V		GND		GND		GND		GND		3A		"	"
			22	GND		GND	5.5 V	GND		2.4 V		GND		GND		GND		4A		"	"
			23	GND		GND	5.5 V	GND		GND		2.4 V		GND		GND		5A		"	"
			24	GND		GND	5.5 V	GND		GND		GND		GND		2.4 V		6A		"	"
	I_IH2	3010	25	5.5 V		GND	5.5 V	GND		GND		GND		GND		GND		1A		100	µA
			26	GND		5.5 V	5.5 V	GND		GND		GND		GND		GND		2A		"	"
			27	GND		GND	5.5 V	5.5 V		GND		GND		GND		GND		3A		"	"
			28	GND		GND	5.5 V	GND		5.5 V		GND		GND		GND		4A		"	"
			29	GND		GND	5.5 V	GND		GND		5.5 V		GND		GND		5A		"	"
			30	GND		GND	5.5 V	GND		GND		GND		GND		5.5 V		6A		"	"
	I_IL	3009	31	0.4 V		5.5 V	5.5 V	5.5 V		5.5 V		5.5 V		GND		5.5 V		1A	-0.7	-1.6	mA
			32	5.5 V		0.4 V	5.5 V	5.5 V		5.5 V		5.5 V		GND		5.5 V		2A	"	"	"
			33	5.5 V		5.5 V	5.5 V	0.4 V		5.5 V		5.5 V		GND		5.5 V		3A	"	"	"
			34	5.5 V		5.5 V	5.5 V	5.5 V		0.4 V		5.5 V		GND		5.5 V		4A	"	"	"
			35	5.5 V		5.5 V	5.5 V	5.5 V		5.5 V		0.4 V		GND		5.5 V		5A	"	"	"
			36	5.5 V		5.5 V	5.5 V	5.5 V		5.5 V		5.5 V		GND		0.4 V		6A	"	"	"
	I_CCL	3005	37	5.5 V		5.5 V	5.5 V	5.5 V		5.5 V		5.5 V		GND		5.5 V		V_CC		30	mA
	I_CCH	3005	38	GND		GND	5.5 V	GND		GND		GND		GND		GND		V_CC		9.9	mA
	V_IC		39	-12 mA			4.5 V											1A		-1.5	V
			40			-12 mA	4.5 V											2A		"	"
			41				4.5 V	-12 mA										3A		"	"
			42				4.5 V			-12 mA								4A		"	"
			43				4.5 V					-12 mA						5A		"	"
			44				4.5 V									-12 mA		6A		"	"
2				Same tests, terminal conditions and limits as for subgroup 1, except Tc = 125°C and V_IC tests are omitted.																		
3				Same tests, terminal conditions and limits as for subgroup 1, except Tc = -55°C and V_IC tests are omitted.																		

TABLE III. Group A inspection for device type 05 - Continued.

Terminal conditions (pins not designated may be high ≥ 2.0 V, low ≤ 0.8 V or open)

Subgroup	Symbol	MIL-STD-883 method	Test no.	1A	1B	1Y	Vcc	2Y	2A	2B	3Y	3A	3B	GND	4A	4B	4Y	Measured terminal	Min	Max	Unit
				1	2	12	14	6	3	4	5	9	10	7	11	8	13				
9 Tc = 25°C	tPHL	3003 (Fig. 3)	45	IN	OUT	IN	5.0 V	IN	OUT	IN	OUT	IN	OUT	GND			OUT	1A to 1Y	3	20	ns
			46				"							"				2A to 2Y	"	"	"
			47				"							"				3A to 3Y	"	"	"
			48				"							"				4A to 4Y	"	"	"
			49				"							"				5A to 5Y	"	"	"
			50				"							"				6A to 6Y	"	"	"
	tPLH	3003 (Fig. 3)	51	IN	OUT	IN	5.0 V	IN	OUT	IN	OUT	IN	OUT	GND	OUT	IN	OUT	1A to 1Y	3	25	ns
			52				"							"				2A to 2Y	"	"	"
			53				"							"				3A to 3Y	"	"	"
			54				"							"				4A to 4Y	"	"	"
			55				"							"				5A to 5Y	"	"	"
			56				"							"				6A to 6Y	"	"	"
10 Tc = 125°C	tPHL	3003 (Fig. 3)	57	IN	OUT	IN	5.0 V	IN	OUT	IN	OUT	IN	OUT	GND	OUT	IN	OUT	1A to 1Y	3	24	ns
			58				"							"				2A to 2Y	"	"	"
			59				"							"				3A to 3Y	"	"	"
			60				"							"				4A to 4Y	"	"	"
			61				"							"				5A to 5Y	"	"	"
			62				"							"				6A to 6Y	"	"	"
	tPLH	3003 (Fig. 3)	63	IN	OUT	IN	5.0 V	IN	OUT	IN	OUT	IN	OUT	GND	OUT	IN	OUT	1A to 1Y	3	27	ns
			64				"							"				2A to 2Y	"	"	"
			65				"							"				3A to 3Y	"	"	"
			66				"							"				4A to 4Y	"	"	"
			67				"							"				5A to 5Y	"	"	"
			68				"							"				6A to 6Y	"	"	"
11	Same tests, terminal conditions and limits as for subgroup 10, except Tc = -55°C.																				

TABLE III. Group A inspection for device type 06.

Terminal conditions (pins not designated may be high ≥ 2.0 V, low ≤ 0.8 V or open)

Subgroup	Symbol	MIL-STD-883 method	Test no.	1 (1A)	2 (1B)	12 (1Y)	14 (Vcc)	6 (2Y)	3 (2A)	4 (2B)	5 (2C)	9 (3A)	10 (3B)	7 (GND)	11 (3C)	8 (3Y)	13 (1C)	Measured terminal	Min	Max	Unit
1 (Tc = 25°C)	V_{OL}	3007	1	2.0 V	2.0 V	16 mA	4.5 V		5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	GND	5.5 V		2.0 V	1Y		0.4	V
			2	5.5 V	5.5 V		4.5 V	16 mA	2.0 V	2.0 V	2.0 V	5.5 V	5.5 V	GND	5.5 V		5.5 V	2Y			"
			3	5.5 V	5.5 V		4.5 V		5.5 V	5.5 V	5.5 V	2.0 V	2.0 V	GND	2.0 V	16 mA	5.5 V	3Y			"
	I_{CEX}		4	0.8 V	5.5 V	5.5 V	4.5 V		5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	GND	5.5 V		5.5 V	1Y		250	μA
			5	5.5 V	0.8 V	5.5 V	4.5 V		5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	GND	5.5 V		5.5 V	1Y			"
			6	5.5 V	5.5 V	5.5 V	4.5 V		5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	GND	5.5 V		0.8 V	1Y			"
			7	5.5 V	5.5 V		4.5 V	5.5 V	0.8 V	5.5 V	5.5 V	5.5 V	5.5 V	GND	5.5 V		5.5 V	2Y			"
			8	5.5 V	5.5 V		4.5 V	5.5 V	5.5 V	0.8 V	5.5 V	5.5 V	5.5 V	GND	5.5 V		5.5 V	2Y			"
			9	5.5 V	5.5 V		4.5 V		5.5 V	5.5 V	0.8 V	0.8 V	5.5 V	GND	5.5 V		5.5 V	2Y			"
			10	5.5 V	5.5 V		4.5 V		5.5 V	5.5 V	5.5 V	0.8 V	0.8 V	GND	5.5 V		5.5 V	3Y			"
			11	5.5 V	5.5 V		4.5 V		5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	GND	0.8 V	5.5 V	5.5 V	3Y			"
			12	5.5 V	5.5 V		4.5 V		5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	GND	0.8 V		5.5 V	3Y			"
	V_{IC}		13	-12 mA			4.5 V							GND				1A		-1.5	V
			14		-12 mA		4.5 V							GND				1B			"
			15				4.5 V							GND			-12 mA	1C			"
			16				4.5 V		-12 mA					GND				2A			"
			17				4.5 V			-12 mA				GND				2B			"
			18				4.5 V				-12 mA			GND				2C			"
			19				4.5 V					-12 mA		GND				3A			"
			20				4.5 V						-12 mA	GND				3B			"
			21				4.5 V							GND	-12 mA			3C			"
	I_{IH1}	3010	22	2.4 V	GND		5.5 V		GND	GND	GND	GND	GND	GND	GND		GND	1A		40	μA
			23	GND	2.4 V		5.5 V		GND	GND	GND	GND	GND	GND	GND		GND	1B			"
			24	GND	GND		5.5 V		GND	GND	GND	GND	GND	GND	GND		2.4 V	1C			"
			25	GND	GND		5.5 V		2.4 V	GND	GND	GND	GND	GND	GND		GND	2A			"
			26	GND	GND		5.5 V		GND	2.4 V	GND	GND	GND	GND	GND		GND	2B			"
			27	GND	GND		5.5 V		GND	GND	2.4 V	GND	GND	GND	GND		GND	2C			"
			28	GND	GND		5.5 V		GND	GND	GND	2.4 V	GND	GND	GND		GND	3A			"
			29	GND	GND		5.5 V		GND	GND	GND	GND	2.4 V	GND	GND		GND	3B			"
			30	GND	GND		5.5 V		GND	GND	GND	GND	GND	GND	2.4 V		GND	3C			"
	I_{IH2}	3010	31	5.5 V	GND		5.5 V		GND	GND	GND	GND	GND	GND	GND		GND	1A		100	μA
			32	GND	5.5 V		5.5 V		GND	GND	GND	GND	GND	GND	GND		GND	1B			"
			33	GND	GND		5.5 V		GND	GND	GND	GND	GND	GND	GND		5.5 V	1C			"
			34	GND	GND		5.5 V		5.5 V	GND	GND	GND	GND	GND	GND		GND	2A			"
			35	GND	GND		5.5 V		GND	5.5 V	GND	GND	GND	GND	GND		GND	2B			"
			36	GND	GND		5.5 V		GND	GND	5.5 V	GND	GND	GND	GND		GND	2C			"
			37	GND	GND		5.5 V		GND	GND	GND	5.5 V	GND	GND	GND		GND	3A			"
			38	GND	GND		5.5 V		GND	GND	GND	GND	5.5 V	GND	GND		GND	3B			"
			39	GND	GND		5.5 V		GND	GND	GND	GND	GND	GND	5.5 V		GND	3C			"
	I_{IL}	3009	40	0.4 V	5.5 V		5.5 V		5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	GND	5.5 V		5.5 V	1A	-0.7	-1.6	mA
			41	5.5 V	0.4 V		5.5 V		5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	GND	5.5 V		5.5 V	1B			"
			42	5.5 V	5.5 V		5.5 V		5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	GND	5.5 V		0.4 V	1C			"
			43	5.5 V	5.5 V		5.5 V		0.4 V	5.5 V	5.5 V	5.5 V	5.5 V	GND	5.5 V		5.5 V	2A			"
			44	5.5 V	5.5 V		5.5 V		5.5 V	0.4 V	5.5 V	5.5 V	5.5 V	GND	5.5 V		5.5 V	2B			"
			45	5.5 V	5.5 V		5.5 V		5.5 V	5.5 V	0.4 V	5.5 V	5.5 V	GND	5.5 V		5.5 V	2C			"
			46	5.5 V	5.5 V		5.5 V		5.5 V	5.5 V	5.5 V	0.4 V	5.5 V	GND	5.5 V		5.5 V	3A			"
			47	5.5 V	5.5 V		5.5 V		5.5 V	5.5 V	5.5 V	5.5 V	0.4 V	GND	5.5 V		5.5 V	3B			"
			48	5.5 V	5.5 V		5.5 V		5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	GND	0.4 V		5.5 V	3C			"
	I_{CCL}	3005	49	5.5 V	5.5 V		5.5 V		5.5 V	5.5 V	5.5 V	5.5 V	5.5 V	GND	5.5 V		5.5 V	V_{CC}		15	mA
	I_{CCH}	3005	50	GND	GND		5.5 V		GND	GND	GND	GND	GND	GND	GND		GND	V_{CC}		4.95	mA

2 — Same tests, terminal conditions and limits as for subgroup 1, except Tc = 125°C and V_{IC} and V_{IC} tests are omitted.

3 — Same tests, terminal conditions and limits as for subgroup 1, except Tc = -55°C and V_{IC} tests are omitted.

TABLE III. Group A inspection for device type 06 - Continued.

Terminal conditions (pins not designated may be high ≥ 2.0 V, low ≤ 0.8 V or open)

Subgroup	Symbol	MIL-STD-883 method	Cases A, B, C, and D Test no.	1 1A	2 1B	12 1Y	14 V$_{CC}$	6 2Y	3 2A	4 2B	5 2C	9 3A	10 3B	7 GND	11 3C	8 3Y	13 1C	Measured terminal	Min	Max	Unit
9 Tc = 25°C	t$_{PHL}$	3003 (Fig. 3)	51	IN	2.4 V	OUT	5.0 V	OUT	IN	2.4 V	2.4 V	IN	2.4 V	GND	2.4 V	OUT	2.4 V	1A to 1Y	3	23	ns
			52				"							"				2A to 2Y	"	"	"
			53				"											3A to 3Y	"	"	"
	t$_{PLH}$	3003 (Fig. 3)	54	IN	2.4 V	OUT	5.0 V	OUT	IN	2.4 V	2.4 V	IN	2.4 V	GND	2.4 V	OUT	2.4 V	1A to 1Y	3	28	ns
			55				"							"				2A to 2Y	"	"	"
			56				"											3A to 3Y	"	"	"
10 Tc = 125°C	t$_{PHL}$	3003 (Fig. 3)	57	IN	2.4 V	OUT	5.0 V	OUT	IN	2.4 V	2.4 V	IN	2.4 V	GND	2.4 V	OUT	2.4 V	1A to 1Y	3	29	ns
			58				"							"				2A to 2Y	"	"	"
			59				"											3A to 3Y	"	"	"
	t$_{PLH}$	3003 (Fig. 3)	60	IN	2.4 V	OUT	5.0 V	OUT	IN	2.4 V	2.4 V	IN	2.4 V	GND	2.4 V	OUT	2.4 V	1A to 1Y	3	35	ns
			61				"							"				2A to 2Y	"	"	"
			62				"											3A to 3Y	"	"	"
11	Same tests, terminal conditions and limits as for subgroup 10, except Tc = -55°C.																				

TABLE III. Group A inspection for device type 07.

Terminal conditions (pins not designated may be high ≥ 2.0 V, low ≤ 0.8 V or open)

Terminal‑condition column numbering:

Pin	1A	1B	1Y	VCC	2Y	2A	2B	3Y	3A	3B	GND	4A	4B	4Y
Cases A, B, D	1	2	3	4	5	6	7	8	9	10	11	12	13	14
Case C	2	3	1	14	4	5	6	10	8	9	7	11	12	13

Main table (Subgroup 1, Tc = 25°C):

Symbol	MIL‑STD‑883 method	Test no.	1A	1B	1Y	VCC	2Y	2A	2B	3Y	3A	3B	GND	4A	4B	4Y	Measured terminal	Min	Max	Unit
V_OL	3007	1	2.0 V	2.0 V	16 mA	4.5 V		5.5 V	5.5 V		5.5 V	5.5 V	GND	5.5 V	5.5 V		1Y		0.4	V
		2	5.5 V	5.5 V		4.5 V	16 mA	2.0 V	2.0 V		5.5 V	5.5 V	GND	5.5 V	5.5 V		2Y		"	"
		3	5.5 V	5.5 V		4.5 V		5.5 V	5.5 V	16 mA	2.0 V	2.0 V	GND	5.5 V	5.5 V		3Y		"	"
		4	5.5 V	5.5 V		4.5 V		5.5 V	5.5 V		5.5 V	5.5 V	GND	2.0 V	2.0 V	16 mA	4Y		"	"
I_CEX		5	0.8 V	4.5 V	5.5 V	5.5 V		5.5 V	5.5 V		5.5 V	5.5 V	GND	5.5 V	5.5 V		1Y		250	µA
		6	4.5 V	0.8 V	5.5 V	5.5 V		5.5 V	5.5 V		5.5 V	5.5 V	GND	5.5 V	5.5 V		1Y		"	"
		7	5.5 V	5.5 V		5.5 V	5.5 V	0.8 V	4.5 V		5.5 V	5.5 V	GND	5.5 V	5.5 V		2Y		"	"
		8	5.5 V	5.5 V		5.5 V	5.5 V	4.5 V	0.8 V		5.5 V	5.5 V	GND	5.5 V	5.5 V		2Y		"	"
		9	5.5 V	5.5 V		5.5 V		5.5 V	5.5 V	5.5 V	0.8 V	4.5 V	GND	5.5 V	5.5 V		3Y		"	"
		10	5.5 V	5.5 V		5.5 V		5.5 V	5.5 V	5.5 V	4.5 V	0.8 V	GND	5.5 V	5.5 V		3Y		"	"
		11	5.5 V	5.5 V		5.5 V		5.5 V	5.5 V		5.5 V	5.5 V	GND	0.8 V	4.5 V	5.5 V	4Y		"	"
		12	5.5 V	5.5 V		5.5 V		5.5 V	5.5 V		5.5 V	5.5 V	GND	4.5 V	0.8 V	5.5 V	4Y		"	"
I_IH1	3010	13	2.4 V	GND		5.5 V		GND	GND		GND	GND	GND	GND	GND		1A		40	µA
		14	GND	2.4 V		5.5 V		GND	GND		GND	GND	GND	GND	GND		1B		"	"
		15	GND	GND		5.5 V		2.4 V	GND		GND	GND	GND	GND	GND		2A		"	"
		16	GND	GND		5.5 V		GND	2.4 V		GND	GND	GND	GND	GND		2B		"	"
		17	GND	GND		5.5 V		GND	GND		2.4 V	GND	GND	GND	GND		3A		"	"
		18	GND	GND		5.5 V		GND	GND		GND	2.4 V	GND	GND	GND		3B		"	"
		19	GND	GND		5.5 V		GND	GND		GND	GND	GND	2.4 V	GND		4A		"	"
		20	GND	GND		5.5 V		GND	GND		GND	GND	GND	GND	2.4 V		4B		"	"
I_IH2	3010	21	5.5 V	GND		5.5 V		GND	GND		GND	GND	GND	GND	GND		1A		100	µA
		22	GND	5.5 V		5.5 V		GND	GND		GND	GND	GND	GND	GND		1B		"	"
		23	GND	GND		5.5 V		5.5 V	GND		GND	GND	GND	GND	GND		2A		"	"
		24	GND	GND		5.5 V		GND	5.5 V		GND	GND	GND	GND	GND		2B		"	"
		25	GND	GND		5.5 V		GND	GND		5.5 V	GND	GND	GND	GND		3A		"	"
		26	GND	GND		5.5 V		GND	GND		GND	5.5 V	GND	GND	GND		3B		"	"
		27	GND	GND		5.5 V		GND	GND		GND	GND	GND	5.5 V	GND		4A		"	"
		28	GND	GND		5.5 V		GND	GND		GND	GND	GND	GND	5.5 V		4B		"	"
I_IL	3009	29	0.4 V	5.5 V		5.5 V		5.5 V	5.5 V		5.5 V	5.5 V	GND	5.5 V	5.5 V		1A	−0.7	−1.6	mA
		30	5.5 V	0.4 V		5.5 V		5.5 V	5.5 V		5.5 V	5.5 V	GND	5.5 V	5.5 V		1B	"	"	"
		31	5.5 V	5.5 V		5.5 V		0.4 V	5.5 V		5.5 V	5.5 V	GND	5.5 V	5.5 V		2A	"	"	"
		32	5.5 V	5.5 V		5.5 V		5.5 V	0.4 V		5.5 V	5.5 V	GND	5.5 V	5.5 V		2B	"	"	"
		33	5.5 V	5.5 V		5.5 V		5.5 V	5.5 V		0.4 V	5.5 V	GND	5.5 V	5.5 V		3A	"	"	"
		34	5.5 V	5.5 V		5.5 V		5.5 V	5.5 V		5.5 V	0.4 V	GND	5.5 V	5.5 V		3B	"	"	"
		35	5.5 V	5.5 V		5.5 V		5.5 V	5.5 V		5.5 V	5.5 V	GND	0.4 V	5.5 V		4A	"	"	"
		36	5.5 V	5.5 V		5.5 V		5.5 V	5.5 V		5.5 V	5.5 V	GND	5.5 V	0.4 V		4B	"	"	"
I_CCL	3005	37	5.5 V	5.5 V		5.5 V		5.5 V	5.5 V		5.5 V	5.5 V	GND	5.5 V	5.5 V		VCC		20	mA
I_CCH	3005	38	GND	GND		5.5 V		GND	GND		GND	GND	GND	GND	GND		VCC		6.6	mA
V_IC		39	−12 mA			4.5 V							GND				1A		−1.5	V
		40		−12 mA		4.5 V							GND				1B		"	"
		41				4.5 V		−12 mA					GND				2A		"	"
		42				4.5 V			−12 mA				GND				2B		"	"
		43				4.5 V					−12 mA		GND				3A		"	"
		44				4.5 V						−12 mA	GND				3B		"	"
		45				4.5 V							GND	−12 mA			4A		"	"
		46				4.5 V							GND		−12 mA		4B		"	"

Subgroup 2: Same tests, terminal conditions and limits as for subgroup 1, except Tc = 125°C and V_IC tests are omitted.

Subgroup 3: Same tests, terminal conditions and limits as for subgroup 1, except Tc = −55°C and V_IC tests are omitted.

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TABLE III. Group A inspection for device type 07 - Continued.

Terminal conditions (pins not designated may be high ≥ 2.0 V, low ≤ 0.8 V or open)

Subgroup	Symbol	MIL-STD-883 method	Cases A,B,D / Case C Test no.	1 1A	2 1B	3 1Y	14 Vcc	4 2Y	5 2A	6 2B	10 3Y	8 3A	9 3B	7 GND	11 4A	12 4B	13 4Y	Measured terminal	Min	Max	Unit
9 Tc = 25°C	t_PHL	3003 (Fig. 3)	47	IN	2.4 V	OUT	5.0 V	OUT	IN	2.4 V	OUT	IN	2.4 V	GND	IN	2.4 V		1A to 1Y	3	23	ns
			48				"							"			OUT	2A to 2Y	"	"	"
			49															3A to 3Y	"	"	"
			50															4A to 4Y			
	t_PLH	3003 (Fig. 3)	51	IN	2.4 V	OUT	5.0 V	OUT	IN	2.4 V	OUT	IN	2.4 V	GND	IN	2.4 V		1A to 1Y	3	28	ns
			52				"							"			OUT	2A to 2Y	"	"	"
			53															3A to 3Y	"	"	"
			54															4A to 4Y			
10 Tc = 125°C	t_PHL	3003 (Fig. 3)	55	IN	2.4 V	OUT	5.0 V	OUT	IN	2.4 V	OUT	IN	2.4 V	GND	IN	2.4 V		1A to 1Y	3	29	ns
			56				"							"			OUT	2A to 2Y	"	"	"
			57															3A to 3Y	"	"	"
			58															4A to 4Y			
	t_PLH	3003 (Fig. 3)	59	IN	2.4 V	OUT	5.0 V	OUT	IN	2.4 V	OUT	IN	2.4 V	GND	IN	2.4 V		1A to 1Y	3	35	ns
			60				"							"			OUT	2A to 2Y	"	"	"
			61															3A to 3Y	"	"	"
			62															4A to 4Y			
11	Same tests, terminal conditions and limits as for subgroup 10, except Tc = -55°C.																				

TABLE III. Group A inspection for device type 08.

Terminal conditions (pins not designated may be high ≥ 2.0 V, low ≤ 0.8 V or open)

Column terminal assignments (Case C): 1 = 1A, 2 = 2Y, 3 = 2A, 4 = V_CC, 5 = 3A, 6 = 3Y, 7 = 4A, 8 = 4Y, 9 = 5A, 10 = 5Y, 11 = GND, 12 = 6Y, 13 = 6A, 14 = 1Y.
Corresponding Cases A, B, D column numbers: 1A = 1, 2Y = 4, 2A = 3, V_CC = 14, 3A = 5, 3Y = 6, 4A = 9, 4Y = 8, 5A = 11, 5Y = 10, GND = 7, 6Y = 12, 6A = 13, 1Y = 2.

Subgroup	Symbol	MIL-STD-883 method	Test no.	1A	2Y	2A	V_CC	3A	3Y	4A	4Y	5A	5Y	GND	6Y	6A	1Y	Measured terminal	Min	Max	Unit
1 (Tc = 25°C)	V_{OL}	3007	1	2.0 V		5.5 V	4.5 V	5.5 V		5.5 V		5.5 V		GND		5.5 V	16 mA	1Y		0.4	V
			2	5.5 V	16 mA	2.0 V	4.5 V	5.5 V		5.5 V		5.5 V		GND		5.5 V		2Y		0.4	V
			3	5.5 V		5.5 V	4.5 V	2.0 V	16 mA	5.5 V		5.5 V		GND		5.5 V		3Y		0.4	V
			4	5.5 V		5.5 V	4.5 V	5.5 V		2.0 V	16 mA	5.5 V		GND		5.5 V		4Y		0.4	V
			5	5.5 V		5.5 V	4.5 V	5.5 V		5.5 V		2.0 V	16 mA	GND		5.5 V		5Y		0.4	V
			6	5.5 V		5.5 V	4.5 V	5.5 V		5.5 V		5.5 V		GND	16 mA	2.0 V		6Y		0.4	V
	I_{CEX}		7	0.8 V		5.5 V	4.5 V	5.5 V		5.5 V		5.5 V		GND		5.5 V	5.5 V	1Y		250	µA
			8	5.5 V	5.5 V	0.8 V	4.5 V	5.5 V		5.5 V		5.5 V		GND		5.5 V		2Y		250	µA
			9	5.5 V		5.5 V	4.5 V	0.8 V	5.5 V	5.5 V		5.5 V		GND		5.5 V		3Y		250	µA
			10	5.5 V		5.5 V	4.5 V	5.5 V		0.8 V	5.5 V	5.5 V		GND		5.5 V		4Y		250	µA
			11	5.5 V		5.5 V	4.5 V	5.5 V		5.5 V		0.8 V	5.5 V	GND		5.5 V		5Y		250	µA
			12	5.5 V		5.5 V	4.5 V	5.5 V		5.5 V		5.5 V		GND	5.5 V	0.8 V		6Y		250	µA
	V_{IC}		13	-12mA			4.5 V							GND				1A		-1.5	V
			14			-12mA	4.5 V							GND				2A		-1.5	V
			15				4.5 V	-12mA						GND				3A		-1.5	V
			16				4.5 V			-12mA				GND				4A		-1.5	V
			17				4.5 V					-12mA		GND				5A		-1.5	V
			18				4.5 V							GND		-12mA		6A		-1.5	V
	I_{IH1}	3010	19	2.4 V		GND	5.5 V	GND		GND		GND		GND		GND		1A		40	µA
			20	GND		2.4 V	5.5 V	GND		GND		GND		GND		GND		2A		40	µA
			21	GND		GND	5.5 V	2.4 V		GND		GND		GND		GND		3A		40	µA
			22	GND		GND	5.5 V	GND		2.4 V		GND		GND		GND		4A		40	µA
			23	GND		GND	5.5 V	GND		GND		2.4 V		GND		GND		5A		40	µA
			24	GND		GND	5.5 V	GND		GND		GND		GND		2.4 V		6A		40	µA
	I_{IH2}	3010	25	5.5 V		GND	5.5 V	GND		GND		GND		GND		GND		1A		100	µA
			26	GND		5.5 V	5.5 V	GND		GND		GND		GND		GND		2A		100	µA
			27	GND		GND	5.5 V	5.5 V		GND		GND		GND		GND		3A		100	µA
			28	GND		GND	5.5 V	GND		5.5 V		GND		GND		GND		4A		100	µA
			29	GND		GND	5.5 V	GND		GND		5.5 V		GND		GND		5A		100	µA
			30	GND		GND	5.5 V	GND		GND		GND		GND		5.5 V		6A		100	µA
	I_{IL}	3009	31	0.4 V		5.5 V	5.5 V	5.5 V		5.5 V		5.5 V		GND		5.5 V		1A	-0.7	-1.6	mA
			32	5.5 V		0.4 V	5.5 V	5.5 V		5.5 V		5.5 V		GND		5.5 V		2A	-0.7	-1.6	mA
			33	5.5 V		5.5 V	5.5 V	0.4 V		5.5 V		5.5 V		GND		5.5 V		3A	-0.7	-1.6	mA
			34	5.5 V		5.5 V	5.5 V	5.5 V		0.4 V		5.5 V		GND		5.5 V		4A	-0.7	-1.6	mA
			35	5.5 V		5.5 V	5.5 V	5.5 V		5.5 V		0.4 V		GND		5.5 V		5A	-0.7	-1.6	mA
			36	5.5 V		5.5 V	5.5 V	5.5 V		5.5 V		5.5 V		GND		0.4 V		6A	-0.7	-1.6	mA
	I_{CCL}	3005	37	5.5 V		5.5 V	5.5 V	5.5 V		5.5 V		5.5 V		GND		5.5 V		V_{CC}		30	mA
	I_{CCH}	3005	38	GND		GND	5.5 V	GND		GND		GND		GND		GND		V_{CC}		9.9	mA
2				Same tests, terminal conditions and limits as for subgroup 1, except Tc = 125°C and V_{IC} tests are omitted.																		
3				Same tests, terminal conditions and limits as for subgroup 1, except Tc = -55°C and V_{IC} tests are omitted.																		

TABLE III. Group A inspection for device type 08 - Continued.
Terminal conditions (pins not designated may be high ≥ 2.0 V, low ≤ 0.8 V or open)

Terminal-column pin designations:

Terminal	1A	2Y	2A	Vcc	3A	3Y	4A	4Y	5A	5Y	GND	6Y	6A	1Y
Cases A, B, D	1	2	3	4	5	6	7	8	9	10	11	12	13	14
Case C	1	4	3	14	5	6	9	8	11	10	7	12	13	2

Subgroup	Symbol	MIL-STD-883 method	Test no.	1A	2Y	2A	Vcc	3A	3Y	4A	4Y	5A	5Y	GND	6Y	6A	1Y	Measured terminal	Min	Max	Unit
9 Tc = 25°C	tPHL	3003 (Fig. 3)	39	IN	OUT	IN	5.0 V	IN	OUT	IN	OUT	IN	OUT	GND	OUT	IN	OUT	1A to 1Y	3	23	ns
			40				"							"				2A to 2Y	"	"	"
			41				"							"				3A to 3Y	"	"	"
			42				"							"				4A to 4Y	"	"	"
			43				"							"				5A to 5Y	"	"	"
			44				"							"				6A to 6Y	"	"	"
	tPLH	3003 (Fig. 3)	45	IN	OUT	IN	5.0 V	IN	OUT	IN	OUT	IN	OUT	GND	OUT	IN	OUT	1A to 1Y	3	28	ns
			46				"							"				2A to 2Y	"	"	"
			47				"							"				3A to 3Y	"	"	"
			48				"							"				4A to 4Y	"	"	"
			49				"							"				5A to 5Y	"	"	"
			50				"							"				6A to 6Y	"	"	"
10 Tc = 125°C	tPHL	3003 (Fig. 3)	51	IN	OUT	IN	5.0 V	IN	OUT	IN	OUT	IN	OUT	GND	OUT	IN	OUT	1A to 1Y	3	29	ns
			52				"							"				2A to 2Y	"	"	"
			53				"							"				3A to 3Y	"	"	"
			54				"							"				4A to 4Y	"	"	"
			55				"							"				5A to 5Y	"	"	"
			56				"							"				6A to 6Y	"	"	"
	tPLH	3003 (Fig. 3)	57	IN	OUT	IN	5.0 V	IN	OUT	IN	OUT	IN	OUT	GND	OUT	IN	OUT	1A to 1Y	3	35	ns
			58				"							"				2A to 2Y	"	"	"
			59				"							"				3A to 3Y	"	"	"
			60				"							"				4A to 4Y	"	"	"
			61				"							"				5A to 5Y	"	"	"
			62				"							"				6A to 6Y	"	"	"
11																		Same tests, terminal conditions and limits as for subgroup 10, except Tc = -55°C.			

TABLE III. Group A inspection for device type 09.

Terminal conditions (pins not designated may be high ≥ 2.0 V, low ≤ 0.8 V or open)

Subgroup	Symbol	MIL-STD-883 method	Test no.	1 (1A)	2 (1B)	3 (1Y)	4 (2A)	5 (2B)	6 (2Y)	7 (GND)	8 (3Y)	9 (3A)	10 (3B)	11 (4Y)	12 (4A)	13 (4B)	14 (Vcc)	Measured terminal	Min	Max	Unit
1 Tc = 25°C	V_OL	3007	1	2.0 V	2.0 V	16 mA	5.5 V	5.5 V		GND		5.5 V	5.5 V		5.5 V	5.5 V	4.5 V	1Y		0.4	V
			2	5.5 V	5.5 V		2.0 V	2.0 V	16 mA	"		5.5 V	5.5 V		5.5 V	5.5 V	"	2Y		"	"
			3				5.5 V	5.5 V		"	16 mA	2.0 V	2.0 V		5.5 V	5.5 V	"	3Y		"	"
			4							"		5.5 V	5.5 V	16 mA	2.0 V	2.0 V	"	4Y		"	"
	I_CEX		5	0.8 V	4.5 V	5.5 V	5.5 V	5.5 V		GND		5.5 V	5.5 V		5.5 V	5.5 V	4.5 V	1Y		250	µA
			6	4.5 V	0.8 V	"	5.5 V	5.5 V		"							"	1Y		"	"
			7	5.5 V	5.5 V		0.8 V	4.5 V	5.5 V	"							"	2Y		"	"
			8	"	"		4.5 V	0.8 V	"	"							"	2Y		"	"
			9	"	"					"	5.5 V	0.8 V	4.5 V				"	3Y		"	"
			10	"	"					"	"	4.5 V	0.8 V				"	3Y		"	"
			11	"	"					"				5.5 V	0.8 V	4.5 V	"	4Y		"	"
			12	"	"					"				"	4.5 V	0.8 V	"	4Y		"	"
	V_IC		13	-12mA		5.5 V				GND							4.5 V	1A		-1.5	V
			14		-12mA	"				"							"	1B		"	"
			15				-12mA		5.5 V	"							"	2A		"	"
			16					-12mA	"	"							"	2B		"	"
			17							"	5.5 V	-12mA					"	3A		"	"
			18							"	"		-12mA				"	3B		"	"
			19							"				5.5 V	-12mA		"	4A		"	"
			20							"				"		-12mA	"	4B		"	"
	I_IH1	3010	21	2.4 V	GND		GND	GND		GND		GND	GND		GND	GND	5.5 V	1A		40	µA
			22	GND	2.4 V		"	"		"		"	"		"	"	"	1B		"	"
			23	"	GND		2.4 V	GND		"		"	"		"	"	"	2A		"	"
			24	"	"		GND	2.4 V		"		"	"		"	"	"	2B		"	"
			25	"	"		"	GND		"		2.4 V	GND		"	"	"	3A		"	"
			26	"	"		"	"		"		GND	2.4 V		"	"	"	3B		"	"
			27	"	"		"	"		"		"	GND		2.4 V	GND	"	4A		"	"
			28	"	"		"	"		"		"	"		GND	2.4 V	"	4B		"	"
	I_IH2	3010	29	5.5 V	GND		GND	GND		GND		GND	GND		GND	GND	5.5 V	1A		100	µA
			30	GND	5.5 V		"	"		"		"	"		"	"	"	1B		"	"
			31	"	GND		5.5 V	GND		"		"	"		"	"	"	2A		"	"
			32	"	"		GND	5.5 V		"		"	"		"	"	"	2B		"	"
			33	"	"		"	GND		"		5.5 V	GND		"	"	"	3A		"	"
			34	"	"		"	"		"		GND	5.5 V		"	"	"	3B		"	"
			35	"	"		"	"		"		"	GND		5.5 V	GND	"	4A		"	"
			36	"	"		"	"		"		"	"		GND	5.5 V	"	4B		"	"
	I_IL	3009	37	0.4 V	5.5 V		5.5 V	5.5 V		GND		5.5 V	5.5 V		5.5 V	5.5 V	5.5 V	1A	-0.7	-1.6	mA
			38	5.5 V	0.4 V		"	"		"		"	"		"	"	"	1B	"	"	"
			39	"	5.5 V		0.4 V	"		"		"	"		"	"	"	2A	"	"	"
			40	"	"		5.5 V	0.4 V		"		"	"		"	"	"	2B	"	"	"
			41	"	"		"	5.5 V		"		0.4 V	"		"	"	"	3A	"	"	"
			42	"	"		"	"		"		5.5 V	0.4 V		"	"	"	3B	"	"	"
			43	"	"		"	"		"		"	5.5 V		0.4 V	"	"	4A	"	"	"
			44	"	"		"	"		"		"	"		5.5 V	0.4 V	"	4B	"	"	"
	I_CCL	3005	45	5.5 V	5.5 V		5.5 V	5.5 V		GND		5.5 V	5.5 V		5.5 V	5.5 V	5.5 V	V_CC		20	mA
	I_CCH	3005	46	GND	GND		GND	GND		GND		GND	GND		GND	GND	5.5 V	V_CC		6.6	mA
2	Same tests, terminal conditions and limits as for subgroup 1, except Tc = 125°C and V_IC tests are omitted.																				
3	Same tests, terminal conditions and limits as for subgroup 1, except Tc = -55°C and V_IC tests are omitted.																				

TABLE III. Group A inspection for device type 09 - Continued.

Terminal conditions (pins not designated may be high ≥ 2.0 V, low ≤ 0.8 V or open)

Subgroup	Symbol	MIL-STD-883 method	Case C Test no.	1 1A	2 1B	3 1Y	4 2A	5 2B	6 2Y	7 GND	8 3Y	9 3A	10 3B	11 4Y	12 4A	13 4B	14 V_{CC}	Measured terminal	Min	Max	Unit
9 Tc = 25°C	t_{PHL}	3003 (Fig. 3)	47	IN	2.4 V	OUT	IN	2.4 V	OUT	GND	OUT	IN	2.4 V	OUT	IN	2.4 V	5.0 V	1A to 1Y	3	23	ns
			48							"							"	2A to 2Y	"	"	"
			49							"							"	3A to 3Y			
			50							"							"	4A to 4Y			
	t_{PLH}	3003 (Fig. 3)	51	IN	2.4 V	OUT	IN	2.4 V	OUT	GND	OUT	IN	2.4 V	OUT	IN	2.4 V	5.0 V	1A to 1Y	3	28	ns
			52							"							"	2A to 2Y	"	"	"
			53							"							"	3A to 3Y			
			54							"							"	4A to 4Y			
10 Tc = 125°C	t_{PHL}	3003 (Fig. 3)	55	IN	2.4 V	OUT	IN	2.4 V	OUT	GND	OUT	IN	2.4 V	OUT	IN	2.4 V	5.0 V	1A to 1Y	3	29	ns
			56							"							"	2A to 2Y	"	"	"
			57							"							"	3A to 3Y			
			58							"							"	4A to 4Y			
	t_{PLH}	3003 (Fig. 3)	59	IN	2.4 V	OUT	IN	2.4 V	OUT	GND	OUT	IN	2.4 V	OUT	IN	2.4 V	5.0 V	1A to 1Y	3	35	ns
			60							"							"	2A to 2Y	"	"	"
			61							"							"	3A to 3Y			
			62							"							"	4A to 4Y			
11		Same tests, terminal conditions and limits as for subgroup 10, except Tc = -55°C.																			

5. PACKAGING

5.1 Packaging requirements. For acquisition purposes, the packaging requirements shall be as specified in the contract or order (see 6.2). When actual packaging of materiel is to be performed by DoD or in-house contractor personnel, these personnel need to contact the responsible packaging activity to ascertain packaging requirements. Packaging requirements are maintained by the Inventory Control Point's packaging activity within the Military Service or Defense Agency, or within the military service's system command. Packaging data retrieval is available from the managing Military Department's or Defense Agency's automated packaging files, CD-ROM products, or by contacting the responsible packaging activity.

6. NOTES
(This section contains information of a general or explanatory nature that may be helpful, but is not mandatory.)

6.1 Intended use. Microcircuits conforming to this specification are intended for original equipment design applications and logistic support of existing equipment.

6.2 Acquisition requirements. Acquisition documents should specify the following:

a. Title, number, and date of the specification.

b. PIN and compliance identifier, if applicable (see 1.2).

c. Requirements for delivery of one copy of the conformance inspection data pertinent to the device inspection lot to be supplied with each shipment by the device manufacturer, if applicable.

d. Requirements for certificate of compliance, if applicable.

e. Requirements for notification of change of product or process to contracting activity in addition to notification to the qualifying activity, if applicable.

f. Requirements for failure analysis (including required test condition of method 5003 of MIL-STD-883), corrective action, and reporting of results, if applicable.

g. Requirements for product assurance options.

h. Requirements for special carriers, lead lengths, or lead forming, if applicable. These requirements should not affect the part number. Unless otherwise specified, these requirements will not apply to direct purchase by or direct shipment to the Government.

i. Requirements for "JAN" marking.

J. Packaging requirements (see 5.1).

6.3 Superseding information. The requirements of MIL-M-38510 have been superseded to take advantage of the available Qualified Manufacturer Listing (QML) system provided by MIL-PRF-38535. Previous references to MIL-M-38510 in this document have been replaced by appropriate references to MIL-PRF-38535. All technical requirements now consist of this specification and MIL-PRF-38535. The MIL-M-38510 specification sheet number and PIN have been retained to avoid adversely impacting existing government logistics systems and contractor's parts lists.

6.4 Qualification. With respect to products requiring qualification, awards will be made only for products which are, at the time of award of contract, qualified for inclusion in Qualified Manufacturers List QML-38535 whether or not such products have actually been so listed by that date. The attention of the contractors is called to these requirements, and manufacturers are urged to arrange to have the products that they propose to offer to the Federal Government tested for qualification in order that they may be eligible to be awarded contracts or purchase orders for the products covered by this specification. Information pertaining to qualification of products may be obtained from DSCC-VQ, P.O. Box 3990, Columbus, Ohio 43218-3990.

6.5 <u>Abbreviations, symbols, and definitions.</u> The abbreviations, symbols, and definitions used herein are defined in MIL-PRF-38535, MIL-HDBK-1331, and as follows:

GND .... Ground zero voltage potential
V_{IN} .... Voltage level at an input terminal
$V_{I C}$ .... Input clamp voltage
I_{IN} .... Current flowing into an input terminal

6.6 <u>Logistic support.</u> Lead materials and finishes (see 3.3) are interchangeable. Unless otherwise specified, microcircuits acquired for Government logistic support will be acquired to device class B (see 1.2.2), lead material and finish A (see 3.3). Longer length leads and lead forming should not affect the part number.

6.7 <u>Substitutability.</u> The cross-reference information below is presented for the convenience of users. Microcircuits covered by this specification will functionally replace the listed generic-industry type. Generic-industry microcircuit types may not have equivalent operational performance characteristics across military temperature ranges or reliability factors equivalent to MIL-M-35810 device types and may have slight physical variations in relation to case size. The presence of this information should not be deemed as permitting substitution of generic-industry types for MIL-M-38510 types or as a waiver of any of the provisions of MIL-PRF-38535.

Military device type	Generic-industry type
01	5430
02	5420
03	5410
04	5400
05	5404
06	5412
07	5401
08	5405
09	5403

6.8 <u>Changes from previous issue.</u> Marginal notations are not used in this revision to identify changes with respect to the previous issue due to the extensiveness of the changes.

Custodians:
 Army - CR
 Navy - EC
 Air Force - 11
 DLA - CC

Preparing activity:
 DLA - CC

(Project 5962-2072)

Review activities:
 Army - MI, SM
 Navy - AS, CG, MC, SH, TD
 Air Force - 03, 19, 99

NOTE: The activities listed above were interested in this document as of the date of this document. Since organizations and responsibilities can change, you should verify the currency of the information above using the ASSIST Online database at http://assist.daps.dla.mil.